

(19)



(11)

EP 2 413 394 B1

(12)

EUROPEAN PATENT SPECIFICATION

(45) Date of publication and mention
of the grant of the patent:
27.08.2014 Bulletin 2014/35

(51) Int Cl.:
H01L 51/52 ^(2006.01) **H01L 27/32** ^(2006.01)

(21) Application number: **11175528.6**

(22) Date of filing: **27.07.2011**

(54) Display device and organic light emitting diode display

Anzeigevorrichtung und organische lichtemittierende Diodenanzeige

Dispositif d'affichage et affichage à diode électroluminescente organique

(84) Designated Contracting States:
**AL AT BE BG CH CY CZ DE DK EE ES FI FR GB
GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO
PL PT RO RS SE SI SK SM TR**

(30) Priority: **29.07.2010 KR 20100073513**

(43) Date of publication of application:
01.02.2012 Bulletin 2012/05

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EP 2 413 394 B1

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Description

BACKGROUND

1. Field

[0001] The invention relates generally to a display device. More particularly, the invention relates generally to an organic light emitting diode (OLED) display. In addition, the invention relates generally to a sealing substrate that seals a display portion.

2. Description of the Related Art

[0002] A display device includes a self-emissive organic light emitting diode (OLED) display formed in a plate shape. The OLED display is provided with an organic light emitting element that emits light to display an image.

SUMMARY.

[0003] According to an embodiment of the invention, there is provided an OLED display device including: a display substrate, a display portion disposed on the display substrate, a sealing substrate affixed to the display substrate by an adhering layer that surrounds the display unit, the sealing substrate including a composite member including a resin and a plurality of carbon fibers and an insulating member affixed to the composite member at a peripherally outward side of at least three peripheral edges of the composite member, the insulating member including at least one through hole, a metal film disposed at one side of the sealing substrate, facing the display substrate, and a conductive connection portion contacting the metal film through the at least one through hole.

[0004] The carbon fibers may cross each other in the resin.

[0005] The composite member may include a plurality of layers, each of the plurality of layers including a resin and a plurality of carbon fibers, wherein a plurality of carbon fibers arranged in at least one of the plurality of layers and a plurality of carbon fibers arranged in at least another layer among the plurality of layers cross each other.

[0006] The insulating member is affixed to the composite member at a peripherally outward side of at least three peripheral edges of the composite member. The at least one through hole may include a plurality of first through holes through the insulating member. The composite member may include a plurality of second through holes.

[0007] The display device may further include a first conductive portion extending between inner and outer sides of the insulating member through the plurality of first through holes and receiving a first electric signal, and a second conductive portion extending between inner and outer sides of the composite member through the plurality of second through holes and receiving a second electric signal.

[0008] The insulating member may be affixed to the composite member at a peripherally outward side of all peripheral edges of the composite member. The at least one through hole may include a plurality of first through holes and a plurality of second through holes.

[0009] The display device may further include a first conductive portion extending between inner and outer sides of the insulating member through the plurality of first through holes and receiving a first electric signal, and a second conductive portion extending between an inner side of the insulating member, an inner side of the composite member, and an outer side of the insulating member through the plurality of second through holes and receiving a second electric signal.

[0010] The composite member may include a protrusion at a side surface that faces the insulating member, and the insulating member may include a groove receiving the protrusion.

[0011] The composite member may include a plurality of protruding portions spaced apart from each other at a side surface facing the insulating member, and the insulating member may include a plurality of recess portions receiving the protruding portions.

[0012] The insulating member further may include an insulating plate covering an external surface of the composite member.

[0013] The insulating member further may include a protection portion that protectively covers the adhering layer and a side surface of the display substrate.

[0014] The insulating member may be a plastic injection molded material.

[0015] The insulating member may include a negative thermal expansion filler.

[0016] The metal film may include at least one of an aluminum film, an aluminum alloy film, a copper film, and a copper alloy film.

[0017] The display unit disposed on the display substrate may include a common power line and a common electrode, the sealing substrate including first and second through holes, the first conductive portion disposed on inner and outer sides of the sealing substrate and extending through the first through holes, the first conductive portion configured to supply a first electric signal to the common power line, and a second conductive portion disposed on the inner and outer sides of the sealing substrate and extending through the second through holes, the second conductive portion configured to supply a second electric signal to the common electrode.

[0018] The OLED display may further include a pad unit disposed peripherally outward from the display unit, and including a first pad connected with the common power line and a second pad connected with the common electrode, and a conductive adhering layer disposed between the first pad and the first conductive portion and between the second pad and the second conductive portion.

[0019] The common power line may include a first common power line and a second common power line that

cross each other, and wherein the pad unit includes a plurality of the first pad and the second pad iteratively alternated along one direction of the display substrate.

[0020] The conductive adhering layer may be electrically conductive in the thickness direction and electrically insulating in directions other than the thickness direction.

[0021] The OLED display may further include a first pad disposed at an outer side of the display portion and a conductive adhering layer disposed between the first pad and the first conductive connection portion. The second conductive connection portion may be directly attached to the common electrode.

[0022] The OLED display may further include a plurality of spacers disposed at a lower portion of the common electrode. The common electrode may include protruding portions corresponding to the spacers and contacting the second conductive portion.

[0023] The insulating member may be made of a plastic injection molded material.

[0024] The insulating member may include a negative thermal expansion filler.

[0025] The composite member may include a protrusion at a side surface thereof, facing the insulating member. The insulating member may include a groove that receives the protrusion.

[0026] The composite member may include a plurality of protruding portions spaced apart from each other at a side surface, facing the insulating member and the insulating member may include recess portions receiving the protruding portions.

[0027] The insulating member may further include an insulating plate covering an external surface of the composite member.

[0028] The insulating member may further include a protection portion covering the adhering layer and the display substrate.

[0029] At least some of the above and other features of the invention are set out in the claims.

BRIEF DESCRIPTION OF THE DRAWINGS

[0030] The above and other features and advantages will become more apparent to those of ordinary skill in the art upon referring to the following description of embodiments of the invention, which is given below with reference to the attached drawings, in which:

FIG. 1 illustrates a schematic cross-sectional view of an organic light emitting diode (OLED) display according to an embodiment of the invention.

FIG. 2 illustrates a top plan view of a substrate of the OLED display of FIG. 1.

FIG. 3 illustrates a top plan view of a sealing substrate of the OLED display of FIG. 1.

FIG. 4 illustrates a top plan view of an external surface of the sealing substrate of the OLED display of FIG. 1.

FIG. 5 to FIG. 7 illustrate partially enlarged cross-

sectional views of the OLED display according to the embodiment of FIG. 1.

FIG. 8 illustrates a partially enlarged top plan view of a composite member of the OLED display of FIG. 1.

FIG. 9 relates to one variation of FIG. 8, illustrating an exploded perspective view of the composite member of the OLED display of FIG. 1.

FIG. 10 illustrates a schematic cross-sectional view of an OLED display according to another embodiment of the invention.

FIG. 11 illustrates a top plan view of an inner surface of a sealing substrate of the OLED display of FIG. 10.

FIG. 12 illustrates a top plan view of an outer surface of the sealing substrate of the OLED display FIG. 10.

FIG. 13 illustrates a schematic cross-sectional view of an OLED display according to another embodiment of the invention.

FIG. 14 illustrates a schematic cross-sectional view of an OLED display according to another embodiment of the invention.

FIG. 15 illustrates a top plan view of an outer surface of a sealing substrate of an OLED display according to another embodiment of the invention.

FIG. 16 illustrates a schematic cross-sectional view of an OLED display according to another embodiment of the invention.

FIG. 17 illustrates a schematic cross-sectional view of an OLED display according to another embodiment of the invention.

FIG. 18 illustrates a partially enlarged view of the OLED display of FIG. 17.

DETAILED DESCRIPTION

[0031] Embodiments of the invention will now be described more fully hereinafter with reference to the accompanying drawings; however, the invention may be embodied in different forms and should not be construed as limited to the embodiments set forth herein. Rather, these embodiments are provided so that this disclosure will be thorough and complete, and will fully convey the scope of the invention to those skilled in the art.

[0032] In the drawing figures, the dimensions of layers and regions may be exaggerated for clarity of illustration. It will also be understood that when a layer or element is referred to as being "on" another layer or substrate, it can be directly on the other layer or substrate, or intervening layers may also be present. Further, it will also be understood that when a layer is referred to as being "between" two layers, it can be the only layer between the two layers, or one or more intervening layers may also be present. Like reference numerals refer to like elements throughout.

[0033] Herein, unless otherwise specified, terms such as "conductive" and "insulating" refer to electrical conductivity and insulation.

[0034] Herein, unless otherwise specified, the terms

"inner" and "outer" refer to respective directions toward or away from a center of a described display and perpendicular to a plane of the described display (for example, in the direction of the Z-axis shown in FIGS. 1, 10, 13-14 and 16-17). The terms "peripherally inward" and "peripherally outward" refer to respective directions toward or away from a center of a described display in a plane of the described display (for example, in the plane defined by the X-Y-axes shown in FIGS. 2-4, 11, 12, and 15).

[0035] FIG. 1 illustrates a schematic cross-sectional view of an organic light emitting diode (OLED) display according to a first embodiment of the invention.

[0036] Referring to FIG. 1, an OLED display 100 according to the first embodiment includes a substrate 10, a display portion, hereinafter display unit, 40 formed in the substrate 10, and a sealing substrate 20 fixed to the substrate 10 by adhering layers 31 and 32 surrounding the display unit 40. The substrate 10 includes a display area A10, where the display unit 40 is located, and a non-display area peripherally outward from the display area A10. The non-display area may be divided into wires, a sealing area A20, and a pad area A30.

[0037] The display unit 40 includes a plurality of pixels, and an organic light emitting element 43 and a driving circuit are formed in each pixel (see, for example, FIGS. 5 to 7). The organic light emitting element 43 includes a pixel electrode 44, an organic emission layer 45, and a common electrode 42. The driving circuit is formed of at least two thin film transistors including a switching thin film transistor and a driving thin film transistor 51, and at least one capacitor.

[0038] In addition, gate lines, data lines, and common power lines 41 are arranged in each pixel. The gate line transmits a scan signal and the data line transmits a data signal. The common power line 41 applies a common voltage to the driving thin film transistor 51. The common power line 41 may be parallel with the data line, or may be formed of a first common power line that is parallel with the data line and a second common power line that is parallel with the gate line.

[0039] A detailed description of the display unit 40 will be described below. FIG. 1 schematically illustrates the display unit 40 where the common power line 41 and the common electrode 42 are formed.

[0040] The adhering layers 31, 32 include a first adhering layer 31 surrounding the display unit 40 and a second adhering layer 32 located externally or peripherally outward from the first adhering layer 31. In addition, a conductive adhering layer 33 is disposed between the first adhering layer 31 and the second adhering layer 32. The first adhering layer 31 and the second adhering layer 32 may be non-conductive, and may include an inorganic material, such as a glass frit, and a resin. The resin may include a thermosetting resin, such as, for example, an epoxy resin, polyurethane resin, phenol resin, melamine resin, and unsaturated polyester resin. Meanwhile, the material of the first adhering layer 31 and the second

adhering layer is not limited thereto, so far as the material can seal or affix the substrate 10 and the sealing substrate 20. In addition, a moisture absorbing filler (not shown) may be formed between the substrate 10 and the sealing substrate 20 at a location peripherally inward from the first adhering layer 31.

[0041] In the above-stated OLED display 100, the common power line 41 and the common electrode 42 are not connected with a flexible printed circuit (not shown) attached to the pad area A30. The common power line 41 is connected with a first conductive portion 110 formed in the sealing substrate 20 and receives a first electric signal therefrom, and the common electrode 42 is connected with a second conductive portion 120 formed in the sealing substrate 20 and receives a second electric signal therefrom.

[0042] Thus, the OLED display 100 can evenly apply the corresponding electric signal to the common power line 41 and the common electrode 42 without forming the pad areas A30 at four edges (up, down, right, and left) of the substrate 10, while providing a large-sized display unit 40. As a result, the entire structure and the manufacturing process of the OLED display 100 can be simplified while providing a large-sized display unit 40 in which luminance non-uniformity may be prevented.

[0043] FIG. 2 illustrates a top plan view of a substrate of the OLED display of FIG. 1.

[0044] Referring to FIG. 1 and FIG. 2, the substrate 10 is rectangular shaped with a pair of long sides and a pair of short sides. The wires and sealing areas A20 are located peripherally outward from the four edges of the display area A10. The first adhering layer 31, the conductive adhering layer 33, and the second adhering layer 32 are located in the sealing area A20.

[0045] The pad area A30 is located at one of the edges of the substrate 10 peripherally outward from the wires and the sealing area A20. Although FIG. 2 illustrates that the pad area A30 is located at the lower long side of the substrate 10, the location of the pad area A30 is not limited thereto.

[0046] A first pad 35 electrically connected with the common power line 41 of the display unit 40 and a second pad 36 electrically connected with the common electrode 42 of the display unit 40 are located in the wires and sealing area A20. A plurality of first pads 35 and second pads 36 are formed at the four wires and sealing areas A20, and the first pads 35 and the second pads 36 are iteratively alternated along a horizontal direction (x-axis direction in the drawing) and a vertical direction (y-axis direction in the drawing) of the substrate 10.

[0047] In FIG. 2, each second pad 36 is illustrated with a dot pattern and each first pad 35 is illustrated without a dot pattern in order to distinguish between the first pads 35 and the second pads 36. Among the plurality of first pads 35, first pads 35 that are located at the long side of the substrate 10 are electrically connected with the first common power line, and first pads 35 located at the short side of the substrate 10 are electrically connected with

the second common power line. However, FIG. 2 exemplarily shows the locations and the number of first and second pads 35 and 36, and the illustrated locations and numbers are not restrictive.

[0048] The first pads 35 and the second pads 36 are formed at locations corresponding to the conductive adhering layer 33 in the wire and sealing area A20. The conductive adhering layer 33 may be provided to be conductive only in the thickness direction (z-axis direction of the drawing) and non-conductive in directions other than the thickness direction. Accordingly, a short circuit between the first pad 35 and the second pad 36 may be avoided even though one conductive adhering layer 33 contacts both the first pad 35 and the second pad 36.

[0049] A conductive adhering layer 33 having conductivity in all directions may alternatively be used. In this case, the conductive adhering layer 33 may be divided into a first conductive adhering layer (not shown) located corresponding to the first pad and a second conductive adhering layer (not shown) located corresponding to the second pad. In this case, the first conductive adhering layer and the second conductive adhering layer may be separated from each other with a predetermined distance in order to prevent short-circuit therebetween.

[0050] FIG. 3 and FIG. 4 illustrate top plan views of inner and outer surfaces of the sealing substrate in the OLED display of FIG. 1.

[0051] Referring to FIG. 1 to FIG. 4, the sealing substrate 20 is formed in a size that covers the display area A10 and the four wires and sealing areas A20. Thus, the pad area A30 of the substrate 10 may be exposed to the outside without being overlapped with the sealing substrate 20.

[0052] The sealing substrate 20 includes a first through hole 21 through which a first electric signal of the common power line 41 may be applied and a second through hole 22 through which a second electric signal of the common electrode 42 may be applied. In addition, a first conductive portion 110 extends over the inner surface of the sealing substrate 20, through the first through hole 21, and over the outer surface of the sealing substrate 20. A second conductive portion 120 extends over the inner surface of the sealing substrate 20, through the second through hole 22, and over the outer surface of the sealing substrate 20.

[0053] The sealing substrate 20 is formed of a composite member 23 and an insulating member 24 affixed to the external side of the composite member 23. The composite member 23 may include a resin and a plurality of carbon fibers. The first through hole 21 and the first conductive portion 110 are formed in the insulating member 24, and the second through hole 22 and the second conductive portion 120 are formed in the composite member 23.

[0054] The composite member 23 is formed to contact the first adhering layer 31 while entirely facing the display unit 40. The insulating member 24 is affixed to at least three peripherally outward sides of the composite mem-

ber 23 and partially faces the wires and sealing areas A20. The insulating member 24 is equivalent to the composite member 23 in thickness, and may be manufactured through injection molding using plastic.

[0055] FIG. 3 and FIG. 4 illustrate that the insulating member 24 may contact the entire edges of the composite member 23, excluding a part of an edge at one long side thereof. However, the shape of the insulating member 24 is not limited to this, and the shape may be variously modified.

[0056] The substrate 10 of the OLED display 100 may be formed with glass or a polymer resin having a small thermal expansion coefficient, since the substrate 10 may experience the thermal treatment processes several times during the forming of the driving circuit and the organic light emitting element thereon. The composite member 23 may be provided to have a thermal expansion coefficient that is similar to that of the substrate 10 by controlling the content of the carbon fiber and the content of the resin.

[0057] Thus, when the substrate 10 and the sealing substrate 20 are sealed to each other by hardening the first and the second adhering layer 31 and 32 and the conductive adhering layer 33 at high temperature, torsion of the two substrates 10 and 20 due to the thermal expansion coefficient difference therebetween may be avoided, and a bending problem may be avoided in the environment reliability test after the sealing.

[0058] The composite member 23 has conductivity due to the presence of the carbon fiber. If the sealing substrate 20 were to be formed of only the composite member 23 and the first and second conductive portions 110 and 120 were to be directly formed at the surface of the composite member 23, the first conductive portion 110 and the second conductive portion 120 might be short-circuited by the composite member 23. Thus, additional insulating processes such as forming an insulating film at the surface of the composite member 23 and side walls of the first and second through holes 21 and 22 could be required before forming the first and second conductive portions 110 and 120 on the composite member 23.

[0059] However, in the OLED display of the first embodiment, the sealing substrate 20 is divided into the composite member 23 and the insulating member 24 and the first through hole 21, and the first conductive portion 110 are formed in the insulating member 24 so that the first conductive portion 110 and the second conductive portion 120 can be insulated from each other without forming an additional insulator such as an insulating film. The detailed structure and constituent material of composite member 23 will be described below in detailed.

[0060] Referring to FIG. 5, the first conductive portion 110 includes a first inner layer 111 formed in the inner surface of the insulating member 24, a first connection portion 112 that extends through or fills the first through hole 21 while contacting the first inner layer 111, and a first outer layer 113 formed at the outer side of the insulating member 24 while contacting the first connection

portion 112.

[0061] Referring to FIG. 7, the second conductive portion 120 includes a second inner layer 121 formed at the inner surface of the composite member 23, a second connection portion 122 that extends through or fills the second through hole 22 while contacting the second inner layer 121, and a second outer layer 123 formed at the outer surface of the composite member 23 while contacting the second connection portion 122.

[0062] The second conductive portion 120 is directly formed on the composite member 23 so that the composite member 23 and the second conductive portion 120 are conductive to each other. The insulating member 24 may be insulated from the composite member 23 so that the first conductive portion 110 formed on the insulating member 24 is not short-circuited with the second conductive portion 120. The first through hole 21 and the second through hole 22 are formed at a location facing the wires and the sealing areas A20 of the substrate 10.

[0063] The second inner layer 121 is formed in a size that covers the display unit 40 and contacts the first adhering layer 31. The second inner layer 121 may be formed of a metal film having low resistance and an excellent moisture and oxygen interception effect, such as an aluminum film, an aluminum alloy film, a copper film, or a copper alloy film. In addition, the second inner layer 121 may be formed with a metal foil including aluminum or copper.

[0064] The second inner layer 121 is attached to the first adhering layer 31 to cover the display unit 40 peripherally inward from the first adhering layer 31 for protection. The second inner layer may intercept moisture and oxygen entering from the outside to the display unit 40. The external moisture and oxygen may be intercepted by the composite member 23 having a dense structure and then intercepted by the second inner layer 121. Thus, the composite member 23 provided with the second inner layer 121 may provide air-tightness comparable to a glass substrate.

[0065] The second inner layer 121 includes a first extension portion 124 toward the edge of the composite member 23 to be in contact with the second connection portions 122, and may include a plurality of second extension portions 125 (FIG. 3) at the inner side of the insulating member 24 so as to face the second pad 36 of the substrate 10 such that the second inner layer 121 contacts the conductive adhering layer 33. Thus, the second pad 36 of the substrate 10 may be electrically connected with the second inner layer 121 through the conductive adhering layer 33 and the second extension portion 125.

[0066] The first inner layer 111 is formed to contact the conductive adhering layer 33 between the second extension portions 125 of the second inner layer 121. The first inner layer 111 may be formed in plural, for example, as plural segments isolated for each other, each overlapping one or more of the first pads 35, interposing the conductive adhering layer 33 therebetween. Thus, the first pads

35 are electrically connected with the first inner layer 111 through the conductive adhering layer 33. The first inner layer 111 may be formed with a material that is the same as that of the second inner layer 121.

[0067] The first outer layer 113 overlaps all of the plurality of first inner layers 111 at the outer side of the insulating member 24, and the second outer layer 123 is formed at the edge of the long side of the composite member 23 where the second through hole 22 is formed. The first outer layer 113 may be formed at the entire edge of the insulating member 24.

[0068] An external access terminal (not shown) may be attached to the first outer layer 113 and the second outer layer 123. Thus, the first outer layer 113 may receive the first electric signal of the first common power line 41 from the external access terminal and transmit the signal to the first inner layer 111, and the second outer layer 123 may receive the second electric signal of the common electrode 42 from the external access terminal and transmit the signal to the second inner layer 121.

[0069] At least one of the width and thickness of the first outer layer 113 may be greater than that of the first inner layer 111, and the second outer layer 123 may be thicker than the second inner layer 121. The first inner layer 111 and the second inner layer 121 may have the same thickness and the first outer layer 113 and the second outer layer 123 may have the same thickness to thereby prevent occurrence of stepped portions during the sealing process of the substrate 10 and the sealing substrate 20. The above-described structure may be usefully applied to a large-sized OLED display having large current capacity.

[0070] FIG. 5 to FIG. 7 illustrate partially enlarged cross-sectional views of the OLED display according to the first embodiment. FIG. 5 illustrates the first common power line and the first pad in detail, and FIG. 6 illustrates the second common power line and the first pad in detail. In addition, FIG. 7 illustrates the common electrode and the second pad in detail.

[0071] Referring to FIG. 5 to FIG. 7, an organic light emitting element 43 and a driving circuit is formed in each pixel of the display unit 40. The driving circuit is formed of at least two thin film transistors and at least one capacitor. In FIG. 5 to FIG. 7, one thin film transistor 50 and one organic light emitting element 43 are formed in the display unit 40.

[0072] The thin film transistor 50 includes a semiconductor layer 51, a gate electrode 52, a source electrode 53, and a drain electrode 54. The semiconductor layer 51 may be formed as a polycrystalline silicon film, and may include a channel area 511, a source area 512, and a drain area 513. The channel area 511 may be an intrinsic semiconductor not doped with an impurity, and the source area 512 and the drain area 513 may be impurity-doped semiconductors.

[0073] The gate electrode 52 is disposed on the channel area 511 of the semiconductor layer 51, interposing

the gate insulating layer 11 therebetween. The source electrode 53 and the drain electrode 54 are disposed on the gate electrode 52, interposing an interlayer insulating layer 12 therebetween, and respectively connected with the source area 512 and the drain area 513 through a contact hole formed in the interlayer insulating layer 12. A planarization layer 13 is formed on the source electrode 53 and the drain electrode 54, and a pixel electrode 44 is formed on the planarization layer 13. The pixel electrode 44 is connected with the drain electrode 54 through a contact hole of the planarization layer 13.

[0074] A pixel definition layer 14 is formed on the pixel electrode 44 and the planarization layer 13. The pixel definition layer 14 partially exposes the pixel electrode 44 via an opening 141 in each pixel. An organic emission layer 45 is formed on the exposed pixel electrode 44, and the common electrode 42 is formed in the entire area of the display unit 40 to cover the organic emission layer 45 and the pixel definition layer 14. The pixel electrode 44, the organic emission layer 45, and the common electrode 42 form the organic light emitting element 43.

[0075] The pixel electrode 44 may be a hole injection electrode and the common electrode 42 may be an electron injection electrode. In this case, the organic emission layer 45 may be formed of a hole injection layer (HIL), a hole transport layer (HTL), an emission layer, an electron transport layer (ETL), and an electron injection layer (EIL) that are sequentially stacked from the pixel electrode 44. Holes and electrons are injected to the organic emission layer 45 from the pixel electrode 44 and the common electrode 42, and emission of light from the organic emission layer 720 is made when the excitons being the combinations of the injected holes and electrons drop from the excited state to the ground state.

[0076] The pixel electrode 44 may be formed as a transfective conductive layer and the common electrode 42 may be formed as a reflective conductive layer. Light emitted from the organic emission layer 45 is reflected by the common electrode 42 and then emitted to the outside through the substrate 10. Such a light emission structure is called a rear light emission type. The pixel electrode 44 may be formed of a triple-layered film of ITO/silver (Ag)/ITO, and the common electrode 42 may include one of silver (Ag), aluminum (Al), a silver alloy, and an aluminum alloy.

[0077] The first common power line 411 and the second common power line 412 are each formed on the same layer as one of the gate electrode 52, the source electrode 53, and the drain electrode 54. FIG. 5 illustrates that the first common power line 411 is formed on the same layer of the source and drain electrodes 53 and 54 with the same material, and FIG. 6 illustrates that the second common power line 412 is formed on the same layer of the gate electrode 52 with the same material.

[0078] Referring to FIG. 5 and FIG. 6, end portions of the first common power line 411 and the second common power line 412 are extended to the wire and sealing area A20 at the peripherally outward side of the display unit

40. In addition, at least one insulating layer among four insulating layers formed in the display unit 40 may be extended to the wire and sealing area A20. The end portion of the first common power line 411 is covered by the planarization layer 13, and the end portion of the second common power line 412 is covered by the interlayer insulating layer 12 and the planarization layer 13.

[0079] The planarization layer 13 includes a second opening 131 to expose the end portion of the first common power line 411, and a first pad conductive layer 151 is formed on the planarization layer 13 and electrically connected with the first common power line 411 through the second opening 131. The first pad 35 disposed in the long side of the substrate 10 may be referred to herein as the first pad conductive layer 151.

[0080] The interlayer insulating layer 12 and planarization layer 13 include a third opening 16 to expose an end portion of the second common power line 412, and a second pad conductive layer 152 may be formed on the planarization layer 13 and electrically connected with the second common power line 412 through the third opening 16. The first pad 35 disposed at the short side of the substrate 10 may be referred to herein as the second pad conductive layer 152.

[0081] The first pad conductive layer 151 and second pad conductive layer 152 may be formed on the same layer of the pixel electrode 44 with the same material. Then, an additional patterning process for forming the first and second pad conductive layers 151 and 152 can be omitted, and therefore the manufacturing process can be simplified.

[0082] Referring to FIG. 7, the common electrode 42 is disposed peripherally inward from the first adhering layer 31 and the second pad 36 is disposed to extend from a peripherally inward side to a peripherally outward side of the first adhering layer 31 such that the common electrode 42 and the conductive adhering layer 33 are in electrical contact with each other.

[0083] The second pad 36 includes a third pad conductive layer 153, a fourth pad conductive layer 154, and a fifth pad conductive layer 155. The third pad conductive layer 153 is disposed peripherally inward from the first adhering layer 31, and contacts the common electrode 42. The fourth pad conductive layer 154 is connected to the third pad conductive layer 153 through the fourth opening 132 of the planarization layer 13, and extends from a peripherally inward side to a peripherally outward side of the first adhering layer 31. The fifth pad conductive layer 155 is disposed between the conductive adhering layer 33 and the planarization layer 13, and is connected with the fourth pad conductive layer 154 through a fifth opening 133.

[0084] The third pad conductive layer 153 and the fifth pad conductive layer 155 are formed on the same layer as the pixel electrode 44 with the same material. In addition, the fourth pad conductive layer 154 is formed on the same layer as one of the gate electrode 52 and the source and drain electrodes 53 and 54 with the same

material. Thus, an additional patterning process for forming the second pad 36 can be omitted, and therefore the manufacturing process can be simplified.

[0085] FIG. 7 illustrates that the fourth pad conductive layer 154 may be formed on the same layer as the source and drain electrodes 53 and 54. The detailed structure of the second pad 36 is not limited to the illustrated example, and any structure that places the common electrode 42 and the wire and sealing area A20 of the display unit 40 into electrical contact with each other may be used.

[0086] In the previously stated OLED display 100, the substrate 10 may be made of transparent glass or transparent plastic. The substrate 10 made of a transparent plastic material may include at least one of polyether sulfone, polyacrylate, polyether imide, polyethylene naphthalate, polyethylene terephthalate, poly phenylene sulfide, polyarylate, polyimide, polycarbonate, cellulose triacetate, and cellulose acetate propionate.

[0087] A plurality of processes for forming a plurality of pixels on the substrate 10 may be performed and heat may be applied to the substrate 10 during the processes such that the substrate 10 may expand due to the heat. Expansion of the substrate 10 may reduce durability of the OLED display 100 and density of the display unit 40 and therefore a material having a low thermal expansion coefficient is desirable for the substrate 10. The substrate 10 made of glass or plastic has a thermal expansion coefficient approximately between $3 \times 10^{-6}/K$ to $4 \times 10^{-6}/K$.

[0088] FIG. 8 illustrates a partially enlarged top plan view of the composite member of the OLED display of FIG. 1.

[0089] Referring to FIG. 8, the composite member 23 may be made of a carbon composite material including a plurality of carbon fibers 26 and resin 25. The composite member 23 may have a structure in which the carbon fibers 26 are impregnated within the resin 25. In other words, the resin 25 serves as a base layer that surrounds the carbon fibers 26 to fix them as one layer.

[0090] The carbon fibers 26 may have a lower thermal expansion coefficient than the substrate 10. Particularly, the thermal expansion coefficient in the length direction of the carbon fibers 26 may have a negative (-) value. On the other hand, the resin 25 may have a higher thermal expansion coefficient than the substrate 10. Thus, the thermal expansion coefficient of the composite member 23 can be controlled by controlling the amount of carbon fibers 26 and the amount of the resin 25.

[0091] When manufacturing the composite member 23 by compounding the carbon fibers 26 and the resin 25, the thermal expansion coefficient of the composite member 23 may be controlled to be equivalent or similar to that of the substrate 10 by controlling a ratio of the resin 25 and the carbon fibers 26.

[0092] The carbon fibers 26 do not absorb moisture so they may increase the waterproofing ability of the composite member 23. In addition, the composite member 23 including the carbon fibers 26 has excellent mechan-

ical properties so that high mechanical strength may be realized with a small thickness. Thus, the entire thickness of the OLED 100 can be reduced. In addition, the composite member 23 may function to suppress thermal expansion of the first inner layer 111 and the second inner layer 121.

[0093] The plurality of carbon fibers 26 may be arranged to cross each other, and, for example, may be woven with wefts and warps. Although FIG. 8 shows carbon fibers 26 that perpendicularly cross each other, the present embodiments are not limited to the example shown in FIG. 8 and the carbon fibers 26 may cross each other at predetermined angles other than the right angle. According to the configuration described above, the composite member 23 may have a low thermal expansion coefficient throughout the region and the durability of the composite member 23 may be increased.

[0094] As a variation, FIG. 9 illustrates an exploded perspective view of the composite member of the OLED display of FIG. 1.

[0095] Referring to FIG. 9, the composite member 230 is formed of a plurality of layers. For example, the composite member 230 has a structure formed by stacking the first layer L10, a second layer L20, a third layer L30, and a fourth layer L40. Each of the layers L10, L20, L30, and L40 may include a resin 25 and a plurality of carbon fibers 261, 262, 263, and 264.

[0096] The carbon fibers 261 and 264 of the first layer L10 and the fourth layer L40 are arranged along a first direction, and the carbon fibers 262 and 263 of the second and third layers L20 and L30 are arranged along a second direction. The first direction and the second direction may or may not perpendicularly cross each other. FIG. 9 illustrates that the first direction and the second direction perpendicularly cross each other.

[0097] The resin 25 may be integrally hardened by pressure-baking such that the first to fourth layers L10 to L40 form a single composite member 230. When the plurality of carbon fibers 261, 262, 263, and 264 are arranged as described above, torsion of the composite member 230 may be suppressed so that planarity of the composite member 230 can be increased.

[0098] In order to control the thermal expansion coefficient, an angle formed by an arrangement direction of the carbon fibers 261 and 262 in the first and fourth layers L10 and L40 and an arrangement direction of the carbon fibers 262 and 263 in the second and third layers L20 and L30 may be variously set. The thermal expansion coefficient of each of the respective layers L10, L20, L30, and L40 can be easily controlled by controlling the amount of the resin 25 and the carbon fibers 261, 262, 263, and 264 included in the respective layers L10, L20, L30, and L40.

[0099] The OLED display 100 of the first embodiment includes the first conductive portion 110 and the second conductive portion 120 in the sealing substrate 20 to apply the corresponding electric signal to the common power line 41 and the common electrode 42. In this case,

since the sealing substrate 20 has a structure that includes both the composite member 23 and the insulating member 24 instead of only the composite member 23, an insulating film forming process for insulation between the first conductive portion 110 and the second conductive portion 120 can be omitted.

[0100] In addition, since it is not easy to form holes in the composite member 23 including solid carbon fibers 26, the sealing substrate 20 can be easily manufactured by forming the first through holes 21, which may be more numerous than the second through holes 22, in the insulating member 24. The first through holes 21 may be formed together when the insulating member 24 is formed by injection-molding plastic, or the holes of the insulating member 24 may be easily formed after the insulating member 24 is formed.

[0101] FIG. 10 illustrates a schematic cross-sectional view of an OLED display according to another embodiment of the invention, and FIG. 11 and FIG. 12 illustrate plan views of the inner and outer sides, respectively, of a sealing substrate of the OLED display of FIG. 10.

[0102] Referring to FIG. 10 to FIG. 12, an OLED display 200 according to the embodiment of FIG. 10 has the same structure as the embodiment of FIG. 1, except that an insulating member 241 is affixed to surround the entire side surface of a composite member 231 and first and second through holes 21 and 22 are formed in the insulating member 241. Like reference numerals designate like elements of the embodiment of FIG. 1.

[0103] A second inner layer 121 of a second conductive portion 120 includes a first extension portion 124 that extends in the inner side of the insulating member 241 to be in contact with a second connection portion 122 that extends through or fills the second through hole 22. In addition, the second inner layer 121 includes a second pad 36 formed in a substrate 10 and a plurality of second extension portions 125 that extend to the inner side of the insulating member 241. The second outer layer 123 is disposed at the outer side of the insulating member 241.

[0104] The first and second extension portions 124 and 125 are formed through the composite member 231 and the insulating member 241, but the first and second extension portions 124 and 125 are not short-circuited with a first conductive portion 110 because they are spaced apart from a first inner layer 111 on the insulating member 241.

[0105] When the second inner layer 121 is formed of a metal foil, the second inner layer 121 may be fixed to the composite member 231 after forming an oxide film by anodizing at one side of the second inner layer 121, facing the composite member 231. In this case, since the oxide film functions as an insulator, the second inner layer 121 is insulated from the composite member 231 and may be rigidly adhered to the composite member 231 by roughness of the oxide film.

[0106] FIG. 13 illustrates a schematic cross-sectional view of an OLED display according to another embodi-

ment of the invention.

[0107] Referring to FIG. 13, an OLED display 300 according to this embodiment may have the same overall structure as the previously described embodiments, except that a protrusion-groove combination structure is formed at a peripherally outward side surface of a composite member 232 and a peripherally inward side surface of an insulating member 242. FIG. 13 illustrates that the protrusion-groove combination structure may be formed in the structure of the embodiment, of FIG. 10 and like reference numerals designate like elements of the embodiment of FIG. 10.

[0108] A protrusion 271 formed in the shape of "v" protrudes toward an insulating member 242 at the peripherally outward side surface of the composite member 232, and a groove 272 is formed facing the protrusion 272 at an peripherally inward surface of the insulating member 242 for receiving the protrusion 271. The protrusion 271 may be formed by grinding or cutting an edge of the composite member 232. The shape of the protrusion 271 and the shape of the groove 272 are not restrictive, and any protrusion-groove combination structure may be used.

[0109] The sealing substrate 20 may be manufactured through two steps. That is, the composite member 232 including the resin 25 and the carbon fibers 26 may be manufactured by hot-pressing the composite member 232 and then the composite member 232 may be inserted to an injection-mold. The insulating member 242 may be injection-molded by injecting a resin to the edge portion of the composite member 232 in the injection mold. Alternatively, the sealing substrate 20 may be manufactured by pressing the composite member 232 using an upper mold of the injection mold and injection-molding the insulating member 242 by injecting a resin to the edge portion of the composite member 232 in the injection mold.

[0110] A combination structure of a protrusion 271 and a groove 272 of the composite member 232 and the insulating member 242 may enable the insulating member 242 to be more effectively attached to the composite member 232, thereby increasing the bonding force of the composite member 232 and the insulating member 24. Thus, the composition member 232 and the insulating member 242 may not easily separate after the sealing substrate 20 is manufactured.

[0111] FIG. 14 illustrates a schematic cross-sectional view of an OLED display according to another embodiment of the invention.

[0112] Referring to FIG. 14, an OLED display 400 according to this embodiment may have the same overall structure as the previously described embodiments, except that an insulating plate 233 covering the outer side of composite member 232 is further formed. FIG. 14 illustrates that the insulating plate 233 is further formed in the structure of the embodiment of FIG. 13, and like reference numerals designate like elements of the embodiment of FIG. 13. It should be noted however that

such an insulating plate could be formed in embodiments having a different structure from that of FIG. 13.

[0113] The insulating plate 233 may be integrally formed with an insulating member 243 when manufacturing the insulating member 243 by injection molding. The insulating plate 233 may be wholly attached to the outer surface of the composite member 232 to increase the bonding force between the insulating member 243 and the composite member 232 and may insulate the outer surface of the composite member 232. The insulating plate 233 may be thin in order not to increase the thermal expansion coefficient of a sealing substrate 20. For example, the thickness of the insulating plate 233 may be set to be less than 20% to 30% of the thickness of the composite member 232.

[0114] FIG. 15 illustrates a top plan view illustrating an outer surface of a sealing substrate of an OLED display according to another embodiment of the invention.

[0115] Referring to FIG. 15, an OLED display 500 according to this embodiment may have the same overall structure as one of the previously described embodiments, except that gear-teeth-shaped protruding portions 273 and recess portions 274 are formed along an edge of a composite member 234 at a peripherally outward side surface of the composite member 234 and an peripherally inward side surface of an insulating plate 244.

[0116] FIG. 15 illustrates that the protruding portion 273 and the recess portion 274 may be formed in the sealing substrate structure of the embodiment of FIG. 10, and illustration of first and second conductive portions 110 and 120 is omitted. Like reference numerals designate like elements of the embodiment of FIG. 10. The features may however be formed in combination with the features of different embodiments.

[0117] A plurality of protruding portions 273 are formed along the edge of the composite member 234 at the peripherally outward side surface thereof, and the protruding portions 273 are spaced apart from each other. In addition, a plurality of recess portions 274 that receive the protruding portions 273 are formed at a peripherally inward surface of the insulating member 244, facing the plurality of protruding portions 273. The shape of the protruding portions 273 and the shape of the recess portions 274 are not restrictive. Any structure that can combine the protruding portion and the recess portion may be used.

[0118] The protruding portions 273 and the recess portions 274 enlarge a contact area of the composite member 234 and the insulating member 244 to increase the bonding force between the composite member 234 and the insulating member 244. Thus, the composite member 234 and the insulating member 244 may not easily separate after the sealing substrate 20 is manufactured.

[0119] FIG. 16 is a schematic cross-sectional view of an OLED display according to another embodiment of the invention.

[0120] Referring to FIG. 16, an OLED display 600 ac-

cording to this embodiment may have the same overall structure as the previously described embodiments, except that a protection portion 29 is further formed to cover side surfaces of a second adhering layer 32 and a substrate 10 for protection. FIG. 16 illustrates that the protection portion 29 is formed in the structure of the exemplary embodiment of FIG. 10, and like reference numerals designate like elements of the embodiment of FIG. 10. It may however be formed in combination with the features of a different embodiment.

[0121] The protection portion 29 is integrally formed with an insulating member 245, and disposed perpendicularly to the insulating member 245. The protection portion 29 is formed at three edges of the insulating member 245 that are not facing a pad area A30. The protection portion 29 protects a substrate 10 made of a fragile material such as glass, and may function to increase the bending strength of a composite member 235. Such a protection portion 29 may be formed together with the insulating member 245 when manufacturing the insulating member by injection molding.

[0122] In the OLED displays 100 to 600 of the embodiments described herein, the insulating members 24, 241, 242, 243, 244, and 245 may be made of plastic that includes a negative thermal expansion filler.

[0123] Typical plastic has a high thermal expansion coefficient compared to a composite member 23 including a carbon fiber 26. When an insulating member 24 is made of the typical plastic, a stress may be generated between the integrally combined composite member 23 and the insulating member 24 if the peripheral temperature of the OLED display varies by a large difference, thereby causing deformation or separation.

[0124] Thus, the insulation members 24, 241, 242, 243, 244, and 245 may be made of plastic into which the negative thermal expansion filler is saturated so that a thermal expansion coefficient difference with the composite member 23 can be reduced. The negative thermal expansion filler may include at least one of tungsten zirconium (ZrW_2O_8), AM_2O_8 (where, A is Zr or Hf and M is Mo or W), ZrV_2O_7 , and $A_2(MO_4)_3$ (where, A is Zr or Hf and M is Mo or W).

[0125] FIG. 17 is a schematic cross-sectional view of an OLED display according to another embodiment of the invention and FIG. 18 is a partially enlarged view of the OLED display of FIG. 17.

[0126] Referring to FIG. 17 and FIG. 18, an OLED display 700 according to this embodiment may have the same overall structure as any one of the previously described embodiments, except that a second pad is omitted in the OLED display 700 and a second inner layer 121 formed in a sealing substrate 20 contacts a common electrode 420. The OLED display illustrated in FIG. 17 may be based on the OLED display of the embodiment of FIG. 1 as a basic structure, and like reference numerals designate like elements of the embodiments of FIGS. 1 and 10.

[0127] In display unit 40, the common electrode 420

forms a protrusion and depression structure. The common electrode 420 includes plurality of protruding portions 421 that are sealed to the second inner layer 121 formed in the sealing substrate 20. The common electrode 420 may be directly connected with the second conductive portion 120 without passing through a conductive adhering layer 33 and may receive a second electric signal therefrom.

[0128] The protrusion and depression structure of the common electrode 420 can be formed by providing a spacer 17. In this case, a plurality of spacers 17 are formed on a pixel definition layer 14, and the common electrode 420 is formed throughout the entire area of the display unit 40 while covering the plurality of spacers 17. The common electrode 420 is sealed to the second inner layer 121 when sealing the substrate 10 and the sealing substrate 20 by pressing and may be electrically connected with the second conductive portion 120.

[0129] In the OLED display 700 of the embodiment of FIGS. 17 and 18, only the first pad 35 is disposed in a wire and sealing area A20 for applying a first electric signal of a common power line 41. In addition, a second inner layer formed in the sealing substrate with a plurality of second extension portions extended toward a second pad is not provided as in the embodiment of FIG. 1.

[0130] By way of summation and review, since a function of a display unit including a plurality of organic light emitting elements may deteriorate when the display unit is exposed to moisture and oxygen, a technique for sealing the display unit to suppress penetration of external moisture and oxygen is desired. The described technology has been made in an effort to provide a display device in which a sealing function of a display unit and an organic light emitting diode (OLED) display is improved. The OLED display according to the described embodiments may enhance the sealing function of the display unit, may increase luminance uniformity of the screen while providing a large-sized display unit, and may simplify an entire structure and manufacturing process by reducing the number of parts. In addition, the first conductive portion and the second conductive portion can be insulated from each other without providing an insulating means such as an insulating layer to the sealing substrate.

[0131] Embodiments have been disclosed herein, and although specific terms are employed, they are used and are to be interpreted in a generic and descriptive sense only and not for purpose of limitation. Accordingly, it will be understood by those of ordinary skill in the art that various changes in form and details may be made without departing from the scope as set forth in the following claims.

Claims

1. An OLED display device, comprising:

a display substrate (10);

a display portion (40) disposed on the display substrate;

a sealing substrate (20) affixed to the display substrate by an adhering layer (32) that surrounds the display portion, the sealing substrate including a conductive composite member (23) including a resin and a plurality of carbon fibers and an insulating member (24) affixed to the composite member at a peripherally outward side of at least three peripheral edges of the composite member, the insulating member including at least one through hole (21);

a metal film (111) disposed at one side of the sealing substrate, facing the display substrate; and

a conductive connection portion (112) contacting the metal film through the at least one through hole (21).

2. An OLED display device as claimed in claim 1, wherein the carbon fibers cross each other in the resin.

3. An OLED display device as claimed in claim 1 or 2, wherein the composite member (23) includes a plurality of layers, each of the plurality of layers including a resin and a plurality of carbon fibers, wherein a plurality of carbon fibers arranged in at least one of the plurality of layers and a plurality of carbon fibers arranged in at least another layer among the plurality of layers cross each other.

4. An OLED display device as claimed in any preceding claim, wherein the at least one through hole includes a plurality of first through holes (21) through the insulating member, and wherein the composite member includes a plurality of second through holes (22).

5. An OLED display device as claimed in claim 4, wherein the first conductive connection portion (110) extends between inner and outer sides of the insulating member through the plurality of first through holes (21) for receiving a first electric signal; and further comprising a second conductive connection portion (120) extending between inner and outer sides of the composite member through the plurality of second through holes (22) for receiving a second electric signal.

6. An OLED display device as claimed in claim 1, wherein the insulating member (24) is affixed to the composite member at a peripherally outward side of all peripheral edges of the composite member (23) and wherein the at least one through hole includes a plurality of first through holes (21) and a plurality of second through holes (22).

7. An OLED display device as claimed in claim 6,

wherein the first conductive connection portion (110) extends between inner and outer sides of the insulating member (24) through the plurality of first through holes (21) for receiving a first electric signal; and
 further comprising a second conductive connection portion (120) extending between an inner side of the insulating member, an inner side of the composite member, and an outer side of the insulating member through the plurality of second through holes for receiving a second electric signal.

8. An OLED display device as claimed in any preceding claim, wherein the composite member (23) includes a protrusion (271) at a side surface that faces the insulating member, and the insulating member includes a groove (272) receiving the protrusion.
9. An OLED display device as claimed in any preceding claim, wherein the composite member includes a plurality of protruding portions (273) spaced apart from each other at a side surface facing the insulating member, and the insulating member includes a plurality of recess portions (274) receiving the protruding portions.
10. An OLED display device as claimed in any preceding claim, wherein the insulating member (24) further includes an insulating plate (244) covering an external surface of the composite member (23).
11. An OLED display device according to any preceding claim, wherein the insulating member (24) further includes a protection portion that protectively covers the adhering layer (31, 32) and a side surface of the display substrate.
12. An OLED display device as claimed in any preceding claim, wherein the insulating member (24) is a plastic injection molded material.
13. An OLED display device as claimed in claim 12, wherein the insulating member (24) includes a negative thermal expansion filler.
14. An OLED display device as claimed in any preceding claim, wherein the metal film (111, 121) includes at least one of an aluminum film, an aluminum alloy film, a copper film, and a copper alloy film.
15. An OLED display as claimed in claim 5 or 7:

wherein the display portion includes a common power line (41) and a common electrode (42); and
 wherein the first conductive connection portion (110) is configured to supply the first electric signal to the common power line; and

the second conductive connection portion (120) is configured to supply the second electric signal to the common electrode.

16. An OLED display as claimed in claim 15, further comprising:
 a pad unit disposed peripherally outward from the display portion, and including a first pad (35) connected with the common power line (41) and a second pad (36) connected with the common electrode (42); and
 a conductive adhering layer (33) disposed between the first pad (35) and the first conductive connection portion (110) and between the second pad (36) and the second conductive connection portion (120).
17. An OLED display as claimed in claim 16, wherein the common power line (41) includes a first common power line and a second common power line that cross each other, and wherein the pad unit includes a plurality of the first pads (35) and the second pads (36) iteratively alternated along one direction of the display substrate.
18. An OLED display as claimed in claim 16 or 17, wherein the conductive adhering layer (33) is electrically conductive in the thickness direction and electrically insulating in directions other than the thickness direction.
19. An OLED display as claimed in claim 15, further comprising a first pad (35) disposed at an outer side of the display portion and a conductive adhering layer disposed between the first pad and the first conductive connection portion (110), and wherein the second conductive connection portion (120) is directly attached to the common electrode.
20. An OLED display as claimed in claim 19, further comprising a plurality of spacers (17) disposed at a lower portion of the common electrode, wherein the common electrode (420) includes protruding portions (421) corresponding to the spacers and contacting the second conductive connection portion.
21. An OLED display as claimed in one of claims 15 to 20, wherein the insulating member (24) is made of a plastic injection molded material.
22. An OLED display as claimed in claim 21, wherein the insulating member includes a negative thermal expansion filler.
23. An OLED display as claimed in claim 21 or 22, wherein the composite member (23) includes a protrusion (271) at a side surface thereof, facing the insulating member, and the insulating member includes a

groove (272) that receives the protrusion.

24. An OLED display as claimed in one of claims 21 to 23, wherein the composite member (23) includes a plurality of protruding portions (273) spaced apart from each other at a side surface, facing the insulating member and the insulating member includes recess portions (274) receiving the protruding portions.
25. An OLED display as claimed in one of claims 21 to 24, wherein the insulating member further includes an insulating plate (244) covering an external surface of the composite member.
26. An OLED display as claimed in one of claims 21 to 24, wherein the insulating member further includes a protection portion covering the adhering layer (31, 32) and a side surface of the display substrate.

Patentansprüche

1. OLED-Anzeigevorrichtung, umfassend:

ein Anzeigesubstrat (10);
 einen auf dem Anzeigesubstrat angeordneten Anzeigeabschnitt (40);
 ein Dichtungssubstrat (20), das durch eine den Anzeigeabschnitt umgebende Haftschrift (32) am Anzeigesubstrat befestigt ist, wobei das Dichtungssubstrat ein leitfähiges Verbundelement (23), welches ein Harz und eine Vielzahl von Kohlenstofffasern beinhaltet, und ein Isolierelement (24), welches an einer Außenumfangsseite von zumindest drei Umfangskanten des Verbundelements am Verbundelement befestigt ist, beinhaltet, wobei das Isolierelement zumindest ein Durchgangsloch (21) beinhaltet; einen Metallfilm (111), der auf einer dem Anzeigesubstrat gegenüberliegenden Seite des Dichtungssubstrats angeordnet ist, und einen leitfähigen Verbindungsabschnitt (112), der durch das zumindest eine Durchgangsloch (21) mit dem Metallfilm in Kontakt steht.

2. OLED-Anzeigevorrichtung nach Anspruch 1, wobei die Kohlenstofffasern einander im Harz kreuzen.
3. OLED-Anzeigevorrichtung nach Anspruch 1 oder 2, wobei das Verbundelement (23) eine Vielzahl von Schichten beinhaltet, wobei jede der Vielzahl von Schichten ein Harz und eine Vielzahl von Kohlenstofffasern beinhaltet, wobei eine Vielzahl von Kohlenstofffasern, die in zumindest einer der Vielzahl von Schichten angeordnet ist, und eine Vielzahl von Kohlenstofffasern, die in zumindest einer anderen Schicht aus der Vielzahl von Schichten angeordnet ist, einander kreuzen.

4. OLED-Anzeigevorrichtung nach einem der vorangehenden Ansprüche, wobei das zumindest eine Durchgangsloch eine Vielzahl erster Durchgangslöcher (21) durch das Isolierelement beinhaltet und wobei das Verbundelement eine Vielzahl zweiter Durchgangslöcher (22) beinhaltet.

5. OLED-Anzeigevorrichtung nach Anspruch 4, wobei sich der erste leitfähige Verbindungsabschnitt (110) zwischen Innen- und Außenseiten des Isolierelements durch die Vielzahl erster Durchgangslöcher (21) erstreckt, um ein erstes elektrisches Signal zu empfangen; ferner umfassend einen zweiten leitfähigen Verbindungsabschnitt (120), der sich zwischen Innen- und Außenseiten des Verbundelements durch die Vielzahl zweiter Durchgangslöcher (22) erstreckt, um ein zweites elektrisches Signal zu empfangen.

6. OLED-Anzeigevorrichtung nach Anspruch 1, wobei das Isolierelement (24) am Verbundelement an einer Außenumfangsseite aller Umfangskanten des Verbundelements (23) befestigt ist und wobei das zumindest eine Durchgangsloch eine Vielzahl erster Durchgangslöcher (21) und eine Vielzahl zweiter Durchgangslöcher (22) beinhaltet.

7. OLED-Anzeigevorrichtung nach Anspruch 6, wobei sich der erste leitfähige Verbindungsabschnitt (110) zwischen Innen- und Außenseiten des Isolierelements (24) durch die Vielzahl erster Durchgangslöcher (21) erstreckt, um ein erstes elektrisches Signal zu empfangen; ferner umfassend einen zweiten leitfähigen Verbindungsabschnitt (120), der sich zwischen einer Innenseite des Isolierelements, einer Innenseite des Verbundelements und einer Außenseite des Isolierelements durch die Vielzahl zweiter Durchgangslöcher (22) erstreckt, um ein zweites elektrisches Signal zu empfangen.

8. OLED-Anzeigevorrichtung nach einem der vorangehenden Ansprüche, wobei das Verbundelement (23) an einer dem Isolierelement gegenüberliegenden Seitenfläche eine Öffnung (271) beinhaltet und das Isolierelement eine die Öffnung aufnehmende Nut (272) beinhaltet.

9. OLED-Anzeigevorrichtung nach einem der vorangehenden Ansprüche, wobei das Verbundelement auf einer dem Isolierelement gegenüberliegenden Seite eine Vielzahl voneinander beabstandeter hervorstehender Abschnitte (273) beinhaltet und das Isolierelement eine Vielzahl von die hervorstehenden Abschnitte aufnehmenden Vertiefungsabschnitten (274) beinhaltet.

10. OLED-Anzeigevorrichtung nach einem der vorange-

- henden Ansprüche, wobei das Isolierelement (24) ferner eine Isolierplatte (244) beinhaltet, die eine Außenfläche des Verbundelements (23) bedeckt.
11. OLED-Anzeigevorrichtung nach einem der vorangehenden Ansprüche, wobei das Isolierelement (24) ferner einen Schutzabschnitt beinhaltet, der die Haftschrift (31, 32) und eine Seitenfläche des Anzeigesubstrats schützend bedeckt. 5
12. OLED-Anzeigevorrichtung nach einem der vorangehenden Ansprüche, wobei das Isolierelement (24) ein Kunststoff-Spritzgussmaterial ist. 10
13. OLED-Anzeigevorrichtung nach Anspruch 12, wobei das Isolierelement (24) ein Füllmaterial mit negativer thermischer Ausdehnung beinhaltet. 15
14. OLED-Anzeigevorrichtung nach einem der vorangehenden Ansprüche, wobei der Metallfilm (111, 121) zumindest einen Aluminiumfilm, einen Aluminiumlegierungsfilm, einen Kupferfilm und/oder einen Kupferlegierungsfilm beinhaltet. 20
15. OLED-Anzeige nach Anspruch 5 oder 7, wobei der Anzeigeabschnitt eine gemeinsame Versorgungsleitung (41) und eine gemeinsame Elektrode (42) beinhaltet und wobei der erste leitfähige Verbindungsabschnitt (110) gestaltet ist, das erste elektrische Signal an die gemeinsame Versorgungsleitung zu liefern, und der zweite leitfähige Verbindungsabschnitt (120) gestaltet ist, das zweite elektrische Signal an die gemeinsame Elektrode zu liefern. 25 30
16. OLED-Anzeige nach Anspruch 15, ferner umfassend:
eine außenumfänglich am Anzeigeabschnitt angeordnete Pad-Einheit, die ein mit der gemeinsamen Versorgungsleitung (41) verbundenes erstes Pad (35) und ein mit der gemeinsamen Elektrode (42) verbundenes zweites Pad (36) beinhaltet; und
eine leitfähige Haftschrift (33), die zwischen dem ersten Pad (35) und dem ersten leitfähigen Verbindungsabschnitt (110) sowie zwischen dem zweiten Pad (36) und dem zweiten leitfähigen Verbindungsabschnitt (120) angeordnet ist. 35 40 45 50
17. OLED-Anzeige nach Anspruch 16, wobei die gemeinsame Versorgungsleitung (41) eine erste gemeinsame Versorgungsleitung und eine zweite gemeinsame Versorgungsleitung beinhaltet, die einander kreuzen, und wobei die Pad-Einheit eine Vielzahl der ersten Pads (35) und der zweiten Pads (36) beinhaltet, die sich entlang einer Richtung des Anzei-
- gesubstrats iterativ abwechseln.
18. OLED-Anzeige nach Anspruch 16 oder 17, wobei die leitfähige Haftschrift (33) in der Dickenrichtung elektrisch leitfähig und in anderen Richtungen als der Dickenrichtung elektrisch isolierend ist.
19. OLED-Anzeige nach Anspruch 15, ferner umfassend ein erstes Pad (35), das an einer Außenseite des Anzeigeabschnitts angeordnet ist, und eine leitfähige Haftschrift, die zwischen dem ersten Pad und dem ersten leitfähigen Verbindungsabschnitt (110) angeordnet ist, wobei der zweite leitfähige Verbindungsabschnitt (120) direkt an der gemeinsamen Elektrode befestigt ist.
20. OLED-Anzeige nach Anspruch 19, ferner umfassend eine Vielzahl von Abstandhaltern (17), die an einem unteren Abschnitt der gemeinsame Elektrode angeordnet sind, wobei die gemeinsame Elektrode (420) hervorstehende Abschnitte (421) beinhaltet, die den Abstandhaltern entsprechen und mit dem zweiten leitfähigen Verbindungsabschnitt in Kontakt stehen.
21. OLED-Anzeige nach einem der Ansprüche 15 bis 20, wobei das Isolierelement (24) aus einem Kunststoff-Spritzgussmaterial gefertigt ist.
22. OLED-Anzeige nach Anspruch 21, wobei das Isolierelement ein Füllmaterial mit negativer thermischer Ausdehnung beinhaltet.
23. OLED-Anzeige nach Anspruch 21 oder 22, wobei das Verbundelement (23) an einer dem Isolierelement gegenüberliegenden Seitenfläche eine Öffnung (271) beinhaltet und das Isolierelement eine die Öffnung aufnehmende Nut (272) beinhaltet.
24. OLED-Anzeige nach einem der Ansprüche 21 bis 23, wobei das Verbundelement (23) auf einer dem Isolierelement gegenüberliegenden Seite eine Vielzahl voneinander beabstandeter hervorstehender Abschnitte (273) beinhaltet und das Isolierelement die hervorstehenden Abschnitte aufnehmende Vertiefungsabschnitte (274) beinhaltet.
25. OLED-Anzeige nach einem der Ansprüche 21 bis 24, wobei das Isolierelement ferner eine Isolierplatte (244) beinhaltet, die eine Außenfläche des Verbundelements bedeckt.
26. OLED-Anzeige nach einem der Ansprüche 21 bis 24, wobei das Isolierelement ferner einen Schutzabschnitt beinhaltet, der die Haftschrift (31, 32) und eine Seitenfläche des Anzeigesubstrats bedeckt. 55

Revendications

1. Dispositif d'affichage à diodes électro-luminescentes organiques (OLED pour "Organic Light Emitting Diode"), comprenant :
 - un substrat (10) d'affichage ;
 - une section (40) d'affichage disposée sur le substrat d'affichage ;
 - un substrat (20) d'obturation fixé au substrat d'affichage par une couche adhésive (32) qui entoure la section d'affichage, le substrat d'obturation incluant un élément composite conducteur (23) incluant une résine et une pluralité de fibres de carbone et un élément isolant (24) fixé à l'élément composite à un côté périphérique de l'élément composite, l'élément isolant incluant au moins un trou traversant (21) ;
 - un film métallique (111) disposé au niveau d'un côté du substrat d'obturation, faisant face au substrat d'affichage ; et
 - une section conductrice (112) de connexion contactant le film métallique à travers l'au moins un trou traversant (21).
2. Dispositif d'affichage à OLED selon la revendication 1, dans lequel les fibres de carbone se croisent les unes les autres dans la résine.
3. Dispositif d'affichage à OLED selon la revendication 1 ou 2, dans lequel l'élément composite (23) inclut une pluralité de couches, chacune de la pluralité de couches incluant une résine et une pluralité de fibres de carbone, dans lequel une pluralité de fibres de carbone agencée dans au moins une de la pluralité de couches et une pluralité de fibres de carbone agencée dans au moins une autre couche parmi la pluralité de couches se croisent les unes les autres.
4. Dispositif d'affichage à OLED selon l'une quelconque des revendications précédentes, dans lequel l'au moins un trou traversant inclut une pluralité de premiers trous traversants (21) à travers l'élément isolant, et dans lequel l'élément composite inclut une pluralité de seconds trous traversants (22).
5. Dispositif d'affichage à OLED selon la revendication 4, dans lequel la première section conductrice (110) de connexion s'étend entre des côtés interne et externe de l'élément isolant à travers la pluralité de premiers trous traversants (21) pour recevoir un premier signal électrique ; et
 - comprenant en outre une seconde section conductrice (120) de connexion s'étendant entre des côtés interne et externe de l'élément composite à travers la pluralité de seconds trous traversants (22) pour recevoir un second signal électrique.
6. Dispositif d'affichage à OLED selon la revendication 1, dans lequel l'élément isolant (24) est fixé à l'élément composite au niveau d'un côté périphérique vers l'extérieur de tous les bords périphériques de l'élément composite (23) et dans lequel l'au moins un trou traversant inclut une pluralité de premiers trous traversants (21) et une pluralité de seconds trous traversants (22).
7. Dispositif d'affichage à OLED selon la revendication 6, dans lequel la première section conductrice (110) de connexion s'étend entre des côtés interne et externe de l'élément isolant (24) à travers la pluralité de premiers trous traversants (21) pour recevoir un premier signal électrique ; et
 - comprenant en outre une seconde section conductrice (120) de connexion s'étendant entre un côté interne de l'élément isolant, un côté interne de l'élément composite, et un côté externe de l'élément isolant à travers la pluralité de seconds trous traversants pour recevoir un second signal électrique.
8. Dispositif d'affichage à OLED selon l'une quelconque des revendications précédentes, dans lequel l'élément composite (23) inclut une protubérance (271) au niveau d'une surface latérale qui fait face à l'élément isolant, et dans lequel l'élément isolant inclut une rainure (272) recevant la protubérance.
9. Dispositif d'affichage à OLED selon l'une quelconque des revendications précédentes, dans lequel l'élément composite inclut une pluralité de parties en saillie (273) espacées les unes des autres au niveau d'une surface latérale faisant face à l'élément isolant, et dans lequel l'élément isolant inclut une pluralité de parties en creux (274) recevant les parties en saillie.
10. Dispositif d'affichage à OLED selon l'une quelconque des revendications précédentes, dans lequel l'élément isolant (24) inclut en outre une plaque isolante (244) couvrant une surface externe de l'élément composite (23).
11. Dispositif d'affichage à OLED selon l'une quelconque des revendications précédentes, dans lequel l'élément isolant (24) inclut en outre une section de protection qui couvre de façon protectrice la couche adhésive (31, 32) et une surface latérale du substrat d'affichage.
12. Dispositif d'affichage à OLED selon l'une quelconque des revendications précédentes, dans lequel l'élément isolant (24) est une matière plastique moulée par injection.
13. Dispositif d'affichage à OLED selon la revendication 12, dans lequel l'élément isolant (24) inclut un élé-

ment de remplissage à dilatation thermique négative.

14. Dispositif d'affichage à OLED selon l'une quelconque des revendications précédentes, dans lequel le film métallique (111, 121) inclut au moins l'un d'un film d'aluminium, d'un film d'alliage d'aluminium, d'un film de cuivre et d'un film d'alliage de cuivre.

15. Afficheur à OLED selon la revendication 5 ou 7, dans lequel la section d'affichage inclut une ligne commune (41) d'alimentation et une électrode commune (42), et dans lequel la première section conductrice (110) de connexion est constituée pour délivrer le premier signal électrique à la ligne commune d'alimentation ; et la seconde section conductrice (120) de connexion est constituée pour délivrer le second signal électrique à l'électrode commune.

16. Afficheur à OLED selon la revendication 15, comprenant en outre :

une unité de pastilles périphérieurement à l'extérieur de la section d'affichage, et incluant une première pastille (35) connectée à la ligne commune (41) d'alimentation et une seconde pastille (36) connectée à l'électrode commune (42) ; et une couche adhésive conductrice (33) disposée entre la première pastille (35) et la première section conductrice (110) de connexion et entre la seconde pastille (36) et la seconde section conductrice (120) de connexion.

17. Afficheur à OLED selon la revendication 16, dans lequel la ligne commune (41) d'alimentation inclut une première ligne commune d'alimentation et une seconde ligne commune d'alimentation qui se croisent l'une l'autre, et dans lequel l'unité de pastilles inclut une pluralité de premières pastilles (35) et de secondes pastilles (36) alternées de façon itérative le long d'une direction du substrat d'affichage.

18. Afficheur à OLED selon la revendication 16 ou 17, dans lequel la couche adhésive conductrice (33) est conductrice de l'électricité dans la direction de l'épaisseur et isolante de l'électricité dans les directions autres que la direction de l'épaisseur.

19. Afficheur à OLED selon la revendication 15, comprenant en outre une première pastille (35) disposée au niveau d'un côté externe de la section d'affichage et une couche adhésive conductrice disposée entre la première pastille et la première section conductrice (110) de connexion, et dans lequel la seconde section conductrice (120) de connexion est directe-

ment fixée à l'électrode commune.

20. Afficheur à OLED selon la revendication 19, comprenant en outre une pluralité d'écarteurs (17) disposée à la partie inférieure de l'électrode commune, dans lequel l'électrode commune (420) inclut des parties en saillie (421) correspondant aux écarteurs et contactant la seconde section conductrice de connexion.

21. Afficheur à OLED selon l'une des revendications 15 à 20, dans lequel l'élément isolant (24) est fait d'une matière plastique moulée par injection.

22. Afficheur à OLED selon la revendication 21, dans lequel l'élément isolant (24) inclut un élément de remplissage à dilatation thermique négative.

23. Afficheur à OLED selon la revendication 21 ou 22, dans lequel l'élément composite (23) inclut une protubérance (271) au niveau de sa surface latérale, faisant face à l'élément isolant, et l'élément isolant inclut une rainure (272) qui reçoit la protubérance.

24. Afficheur à OLED selon l'une des revendications 21 à 23, dans lequel l'élément composite (23) inclut une pluralité de parties en saillie (273) espacées les unes des autres au niveau d'une surface latérale, faisant face à l'élément isolant et dans lequel l'élément isolant inclut des parties en creux (274) recevant les parties en saillie.

25. Afficheur à OLED selon l'une des revendications 21 à 24, dans lequel l'élément isolant inclut en outre une plaque isolante (244) couvrant une surface externe de l'élément composite.

26. Afficheur à OLED selon l'une des revendications 21 à 24, dans lequel l'élément isolant inclut en outre une section de protection couvrant la couche adhésive (31, 32) et une surface latérale du substrat d'affichage.

45

50

55

FIG. 1

100

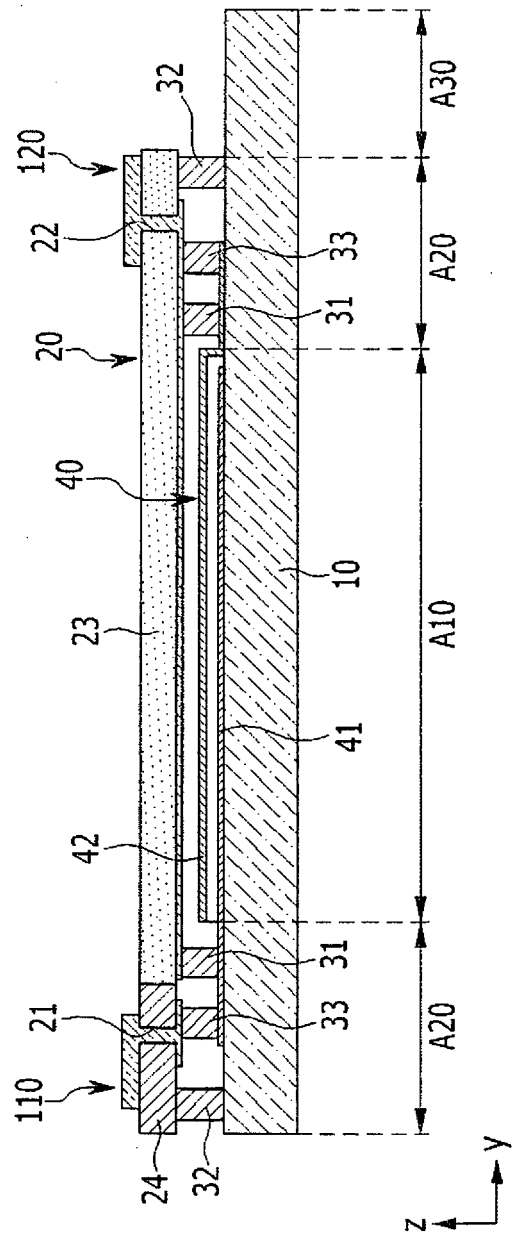


FIG. 2

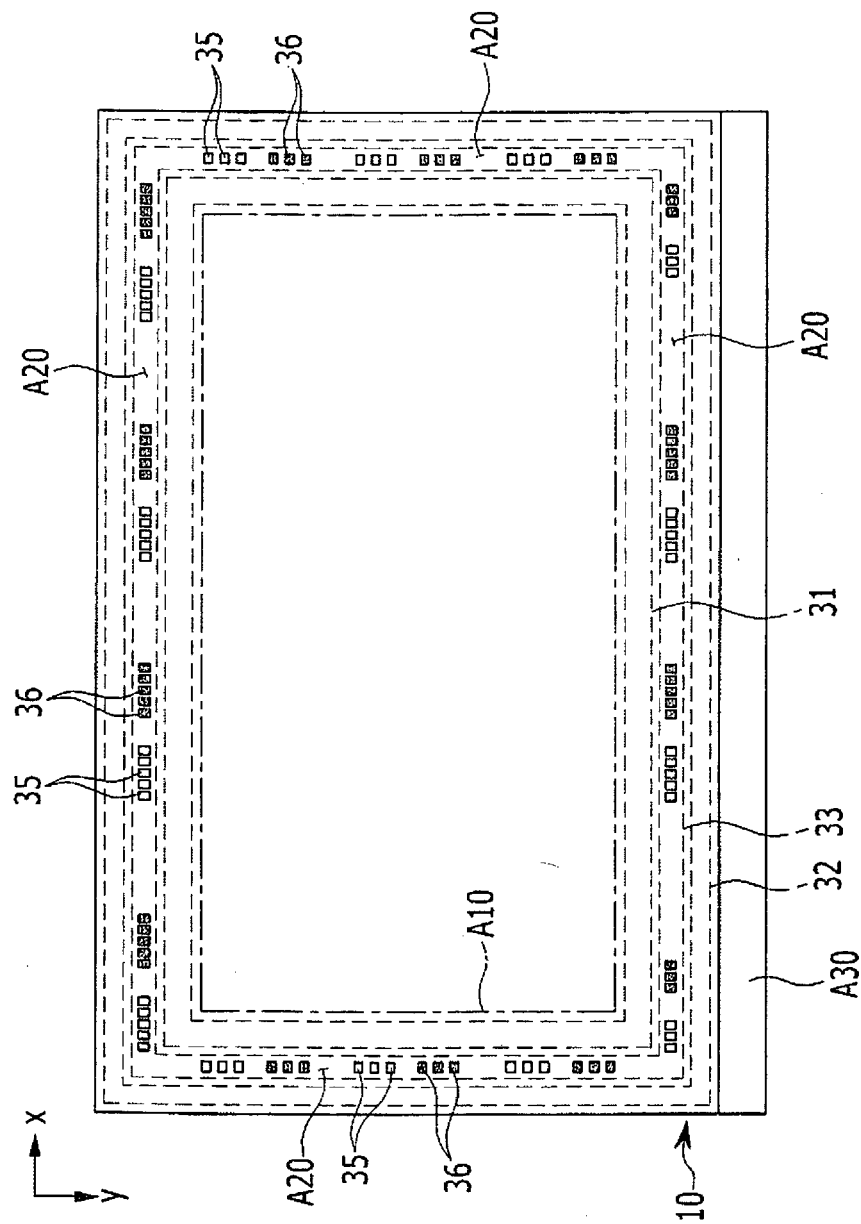


FIG. 3

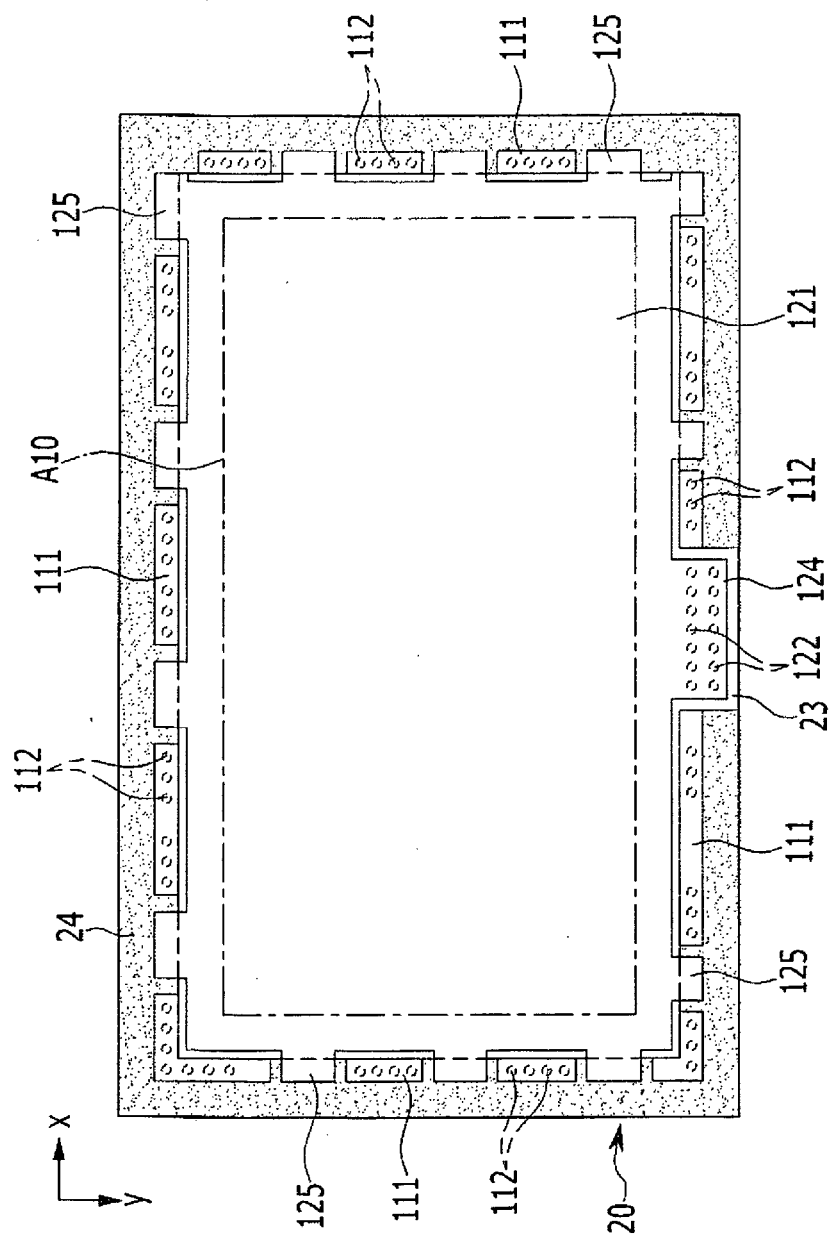


FIG. 4

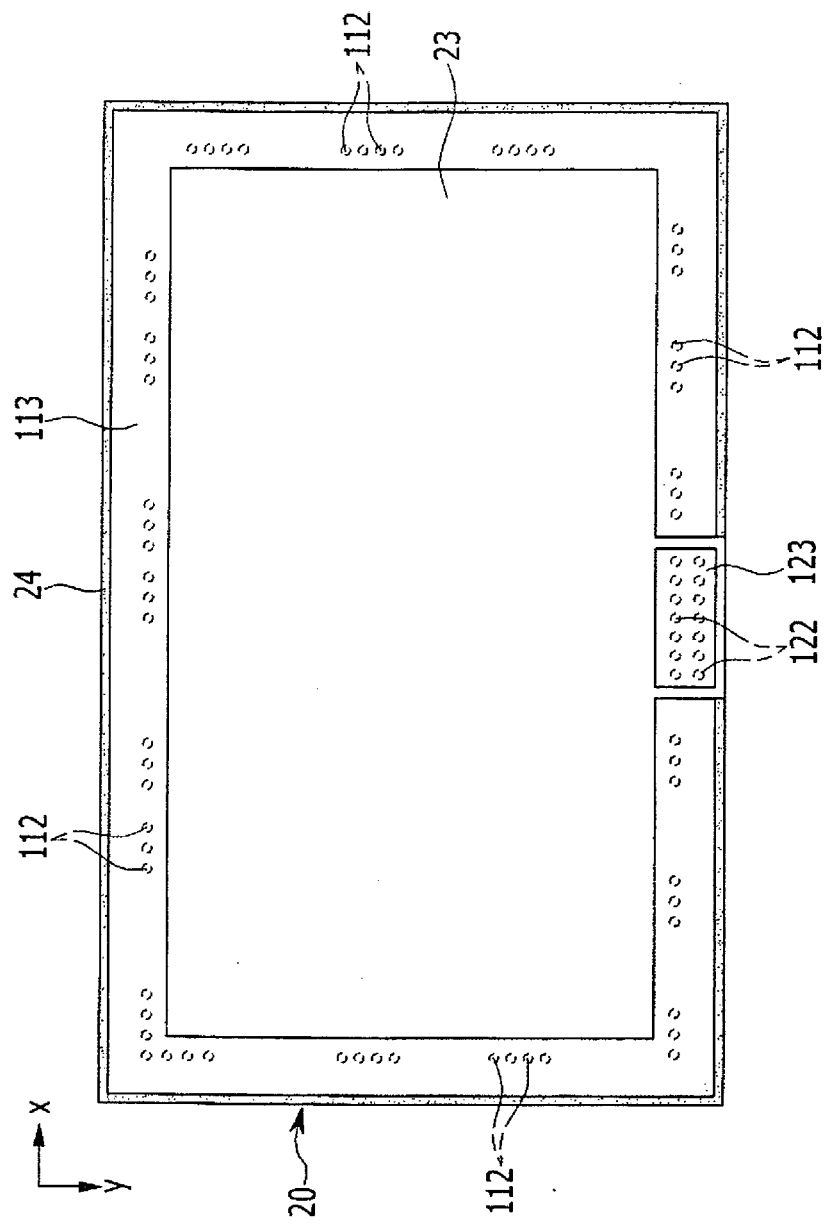


FIG. 5

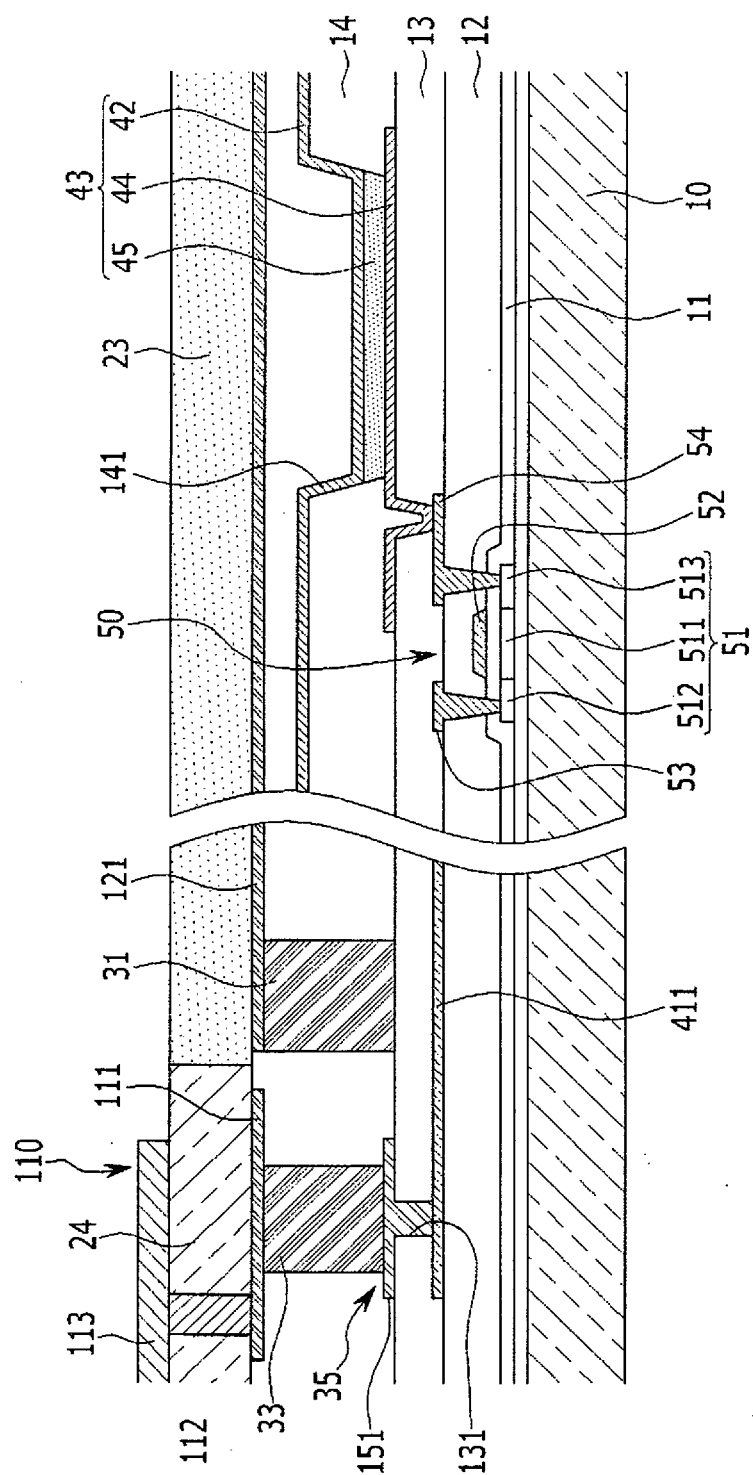


FIG. 6

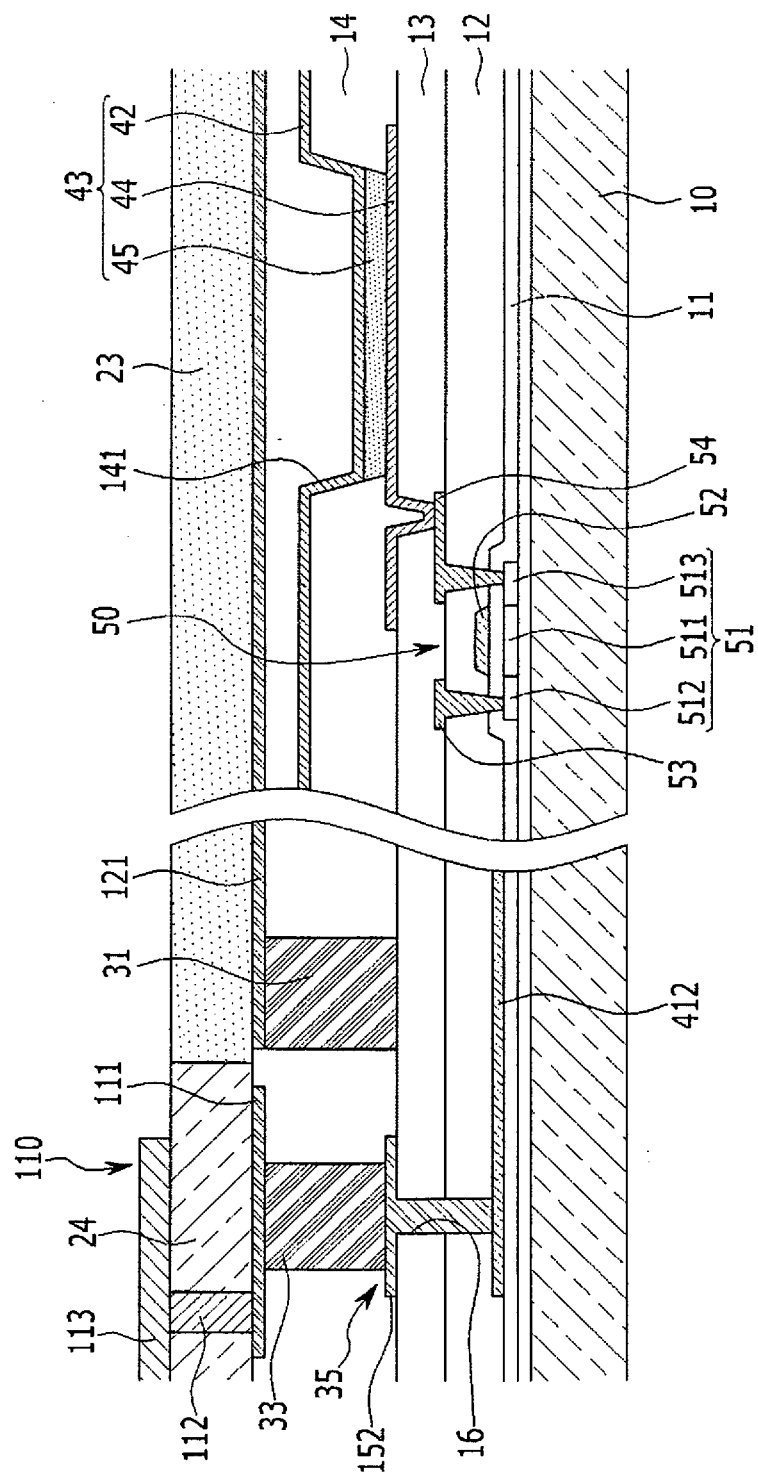


FIG. 7

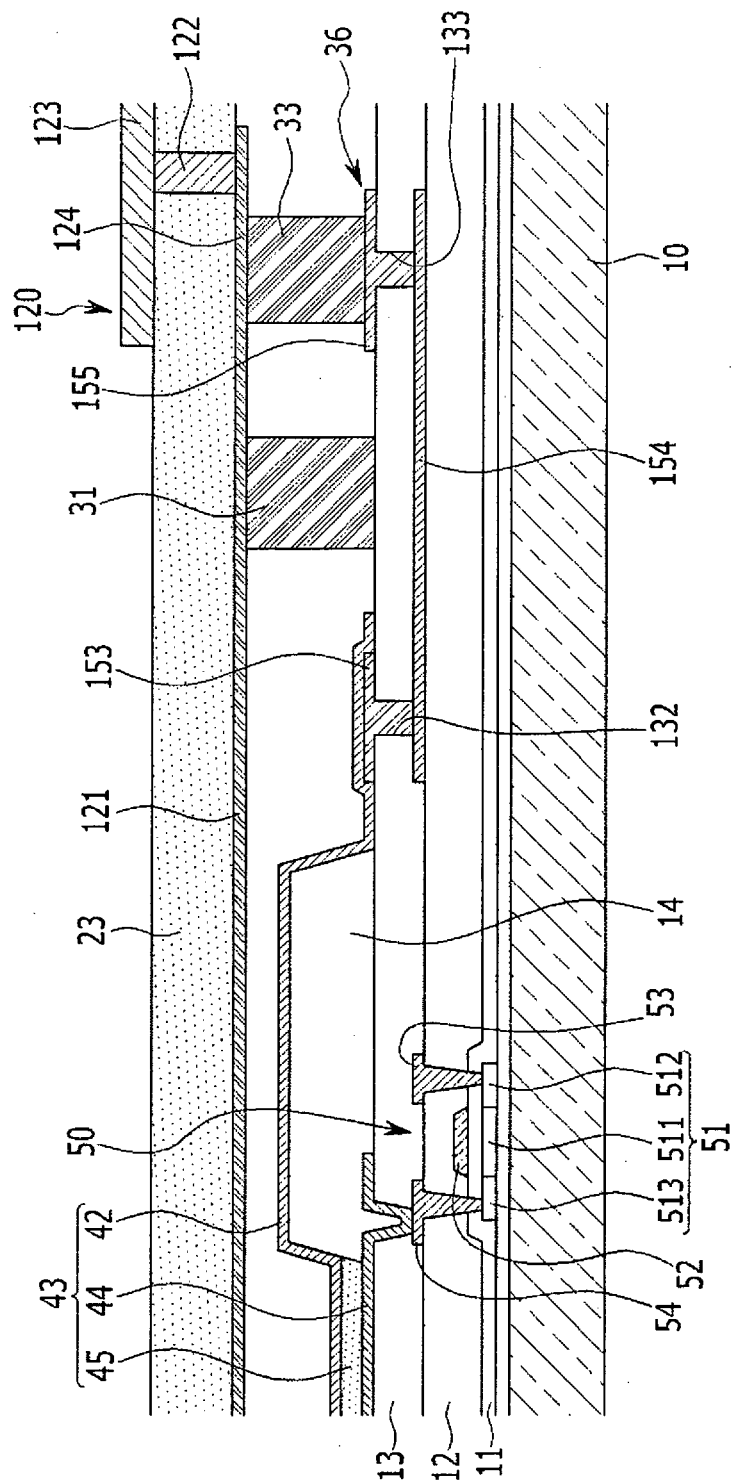


FIG. 8

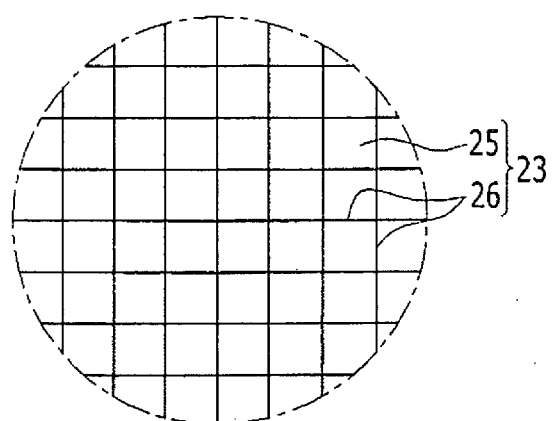


FIG. 9

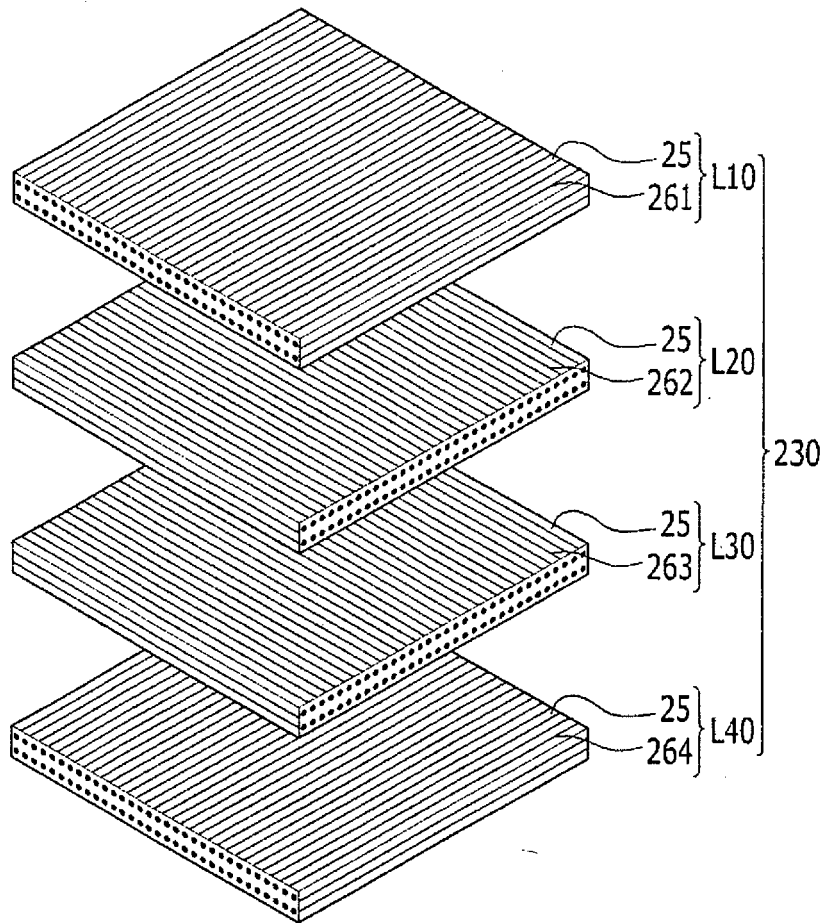


FIG. 10

200

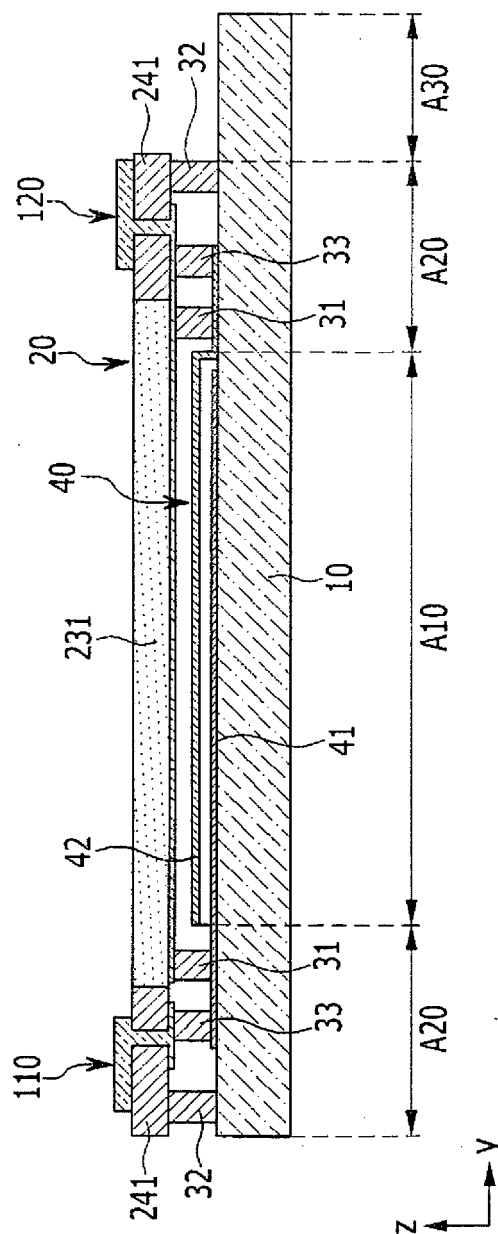


FIG. 11

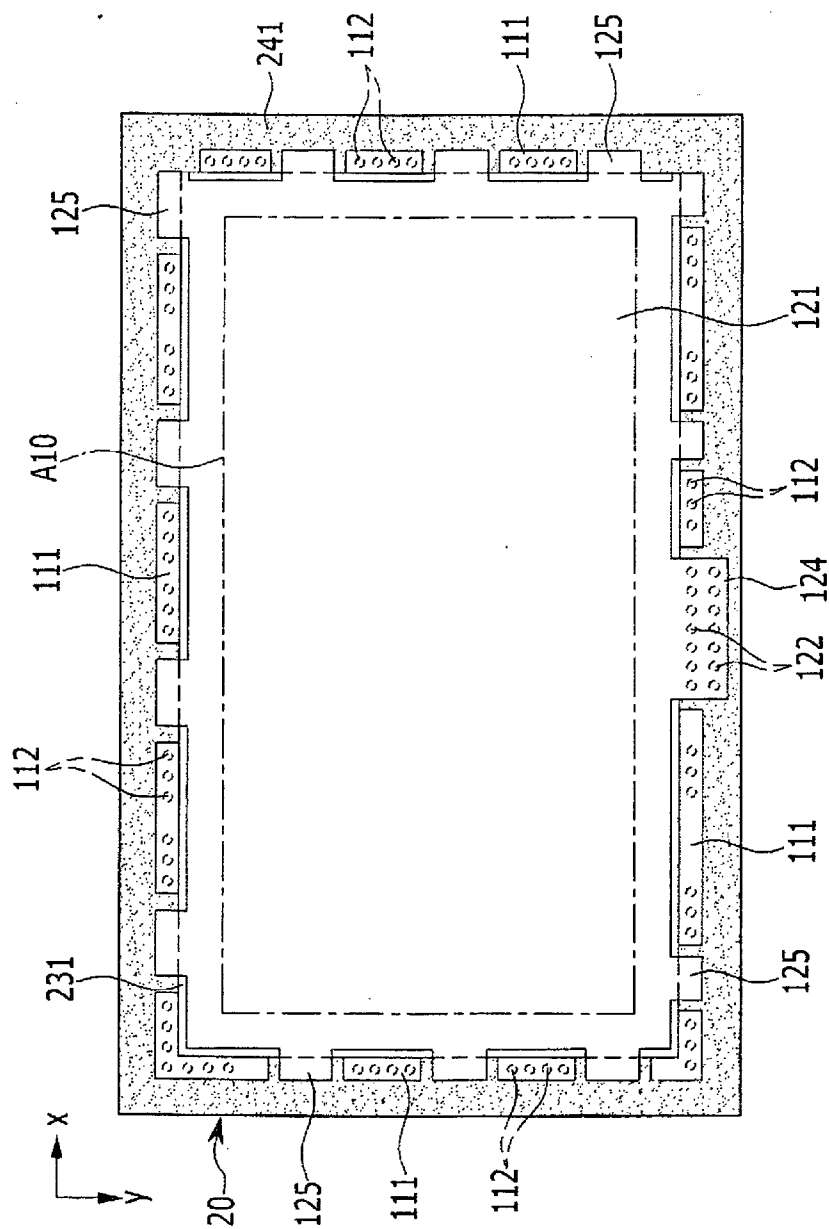


FIG. 12

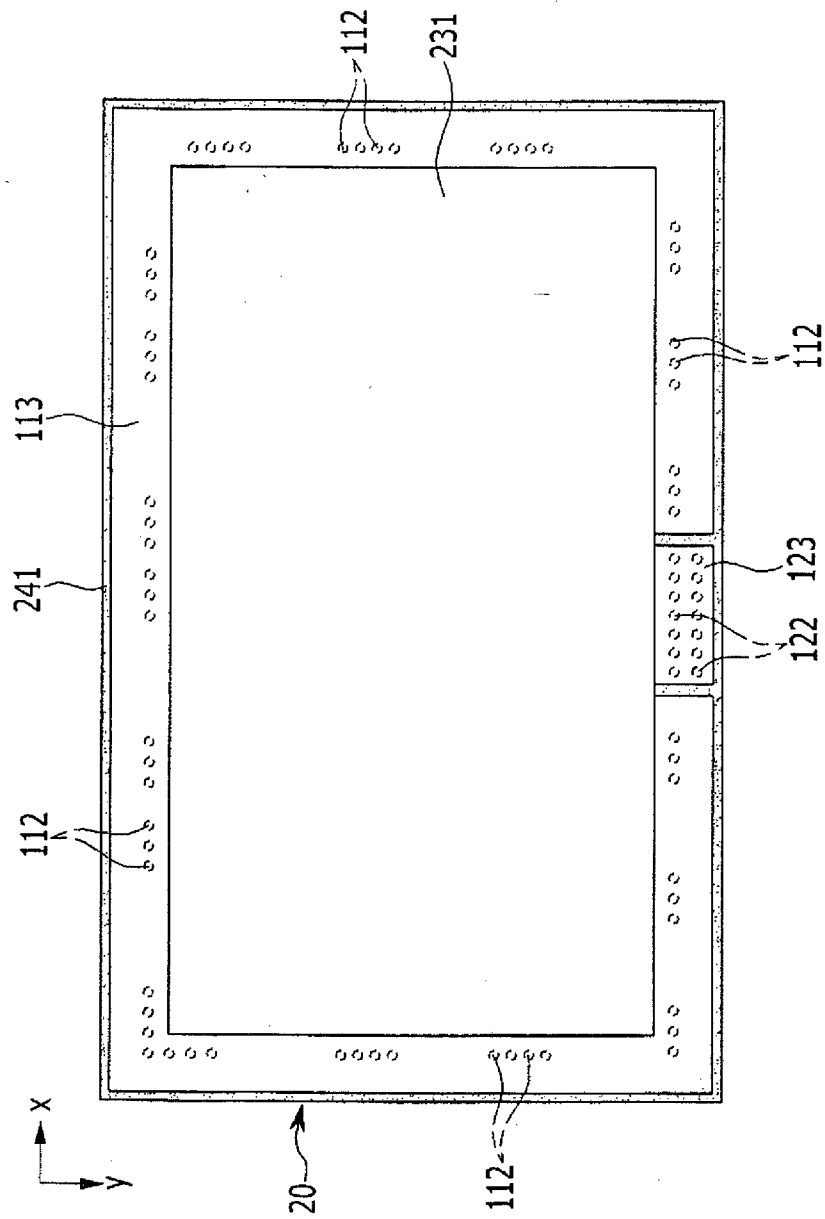


FIG. 13

300

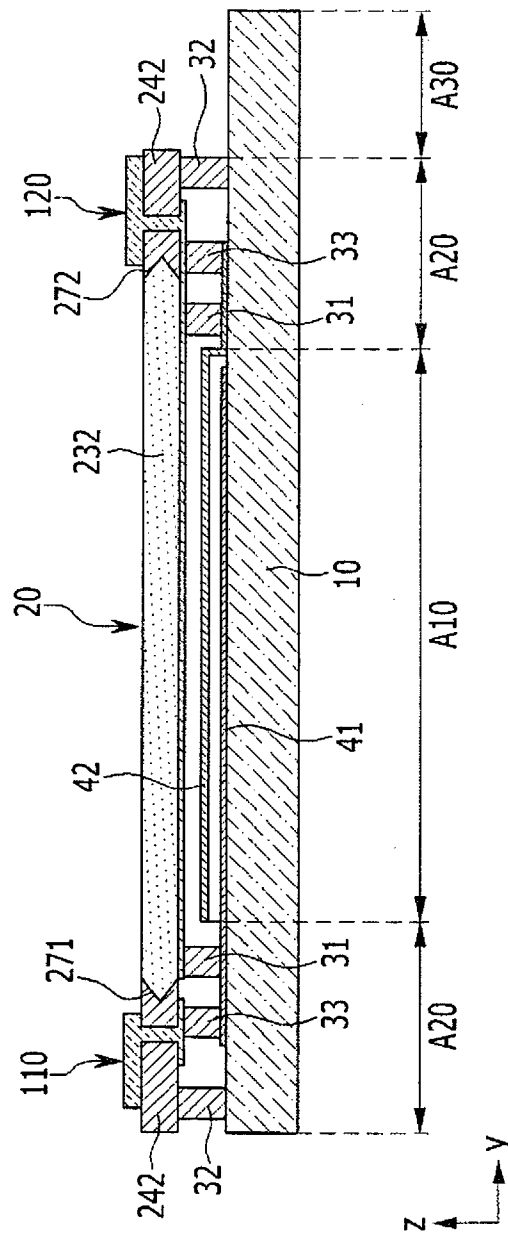


FIG. 14

400

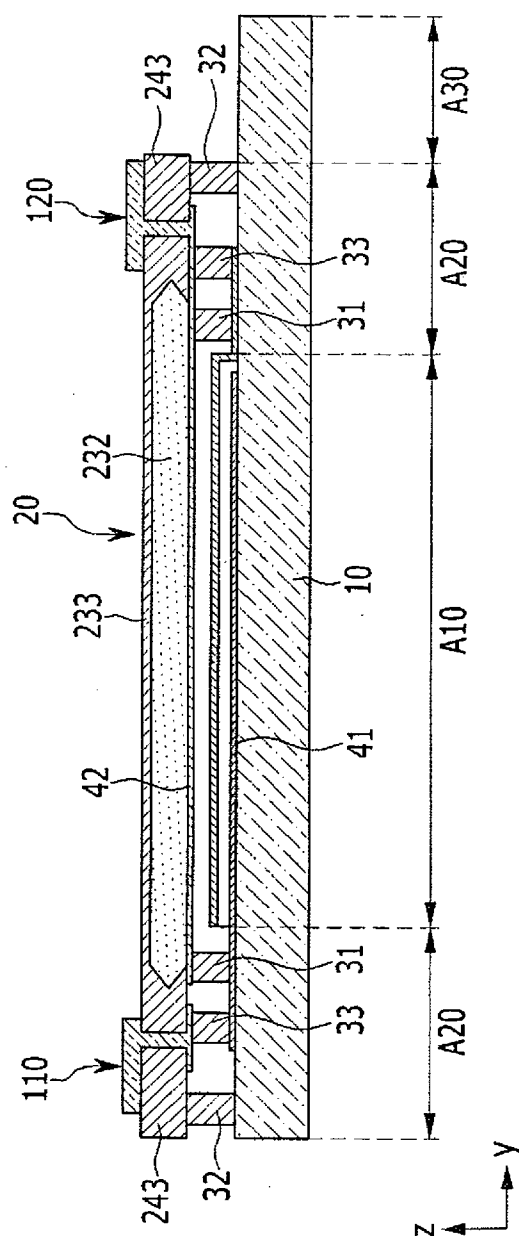


FIG. 15

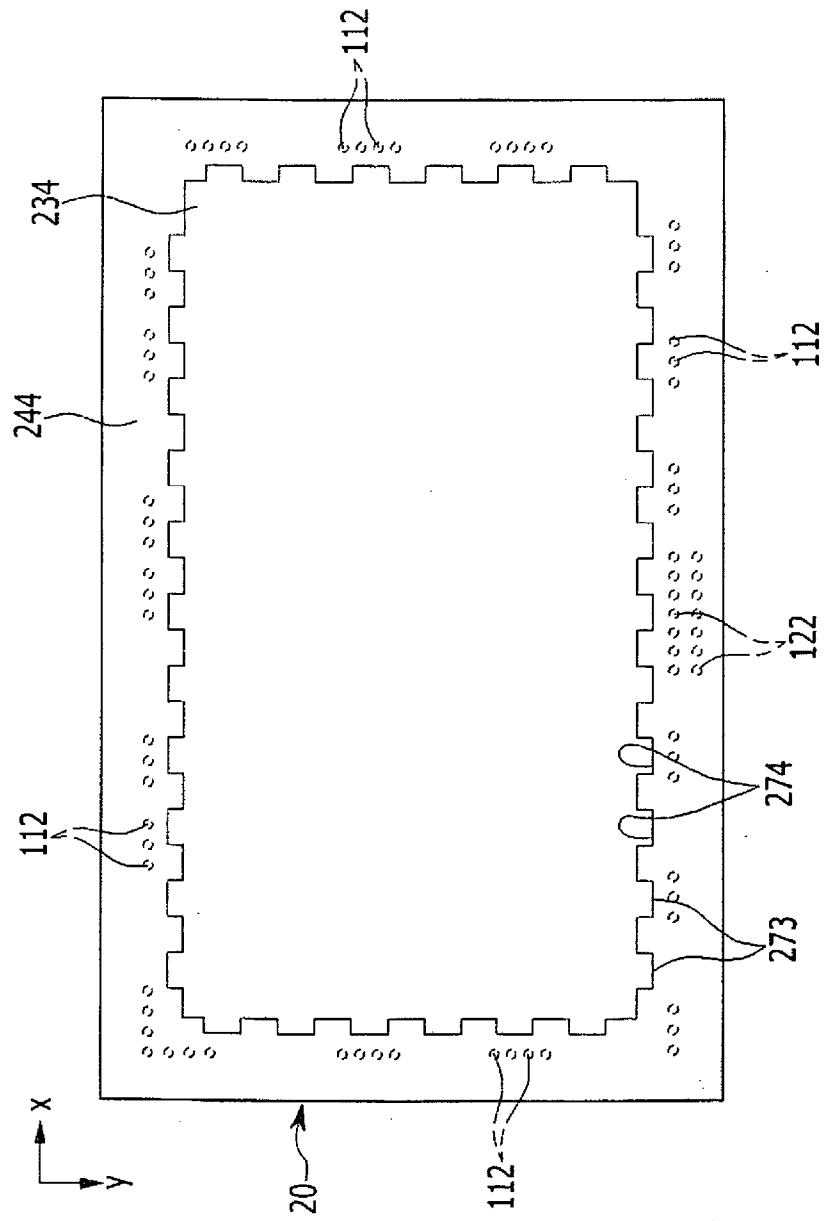


FIG. 16

600

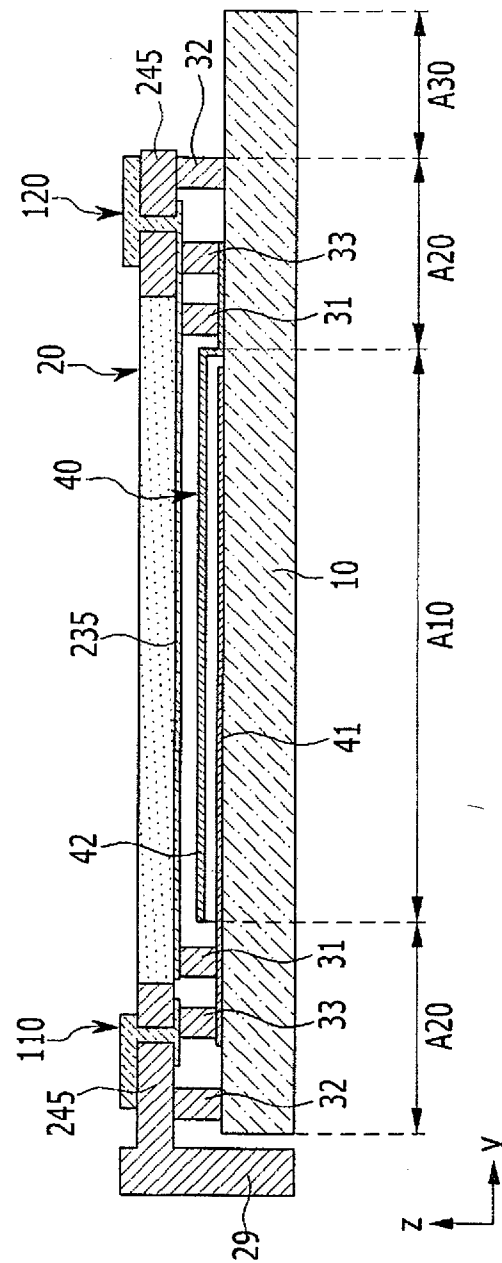


FIG. 17

700

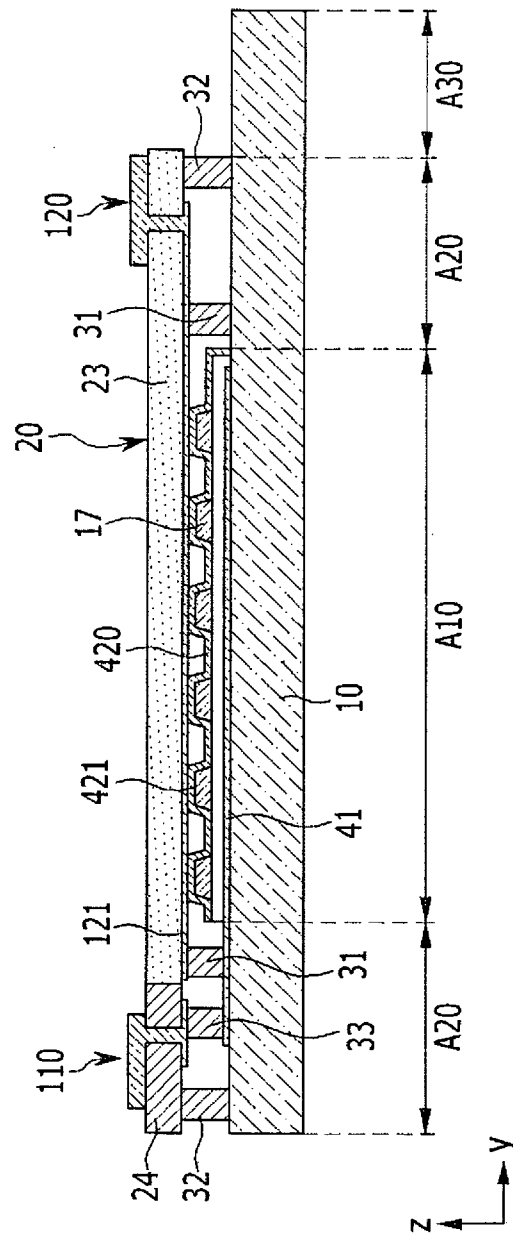
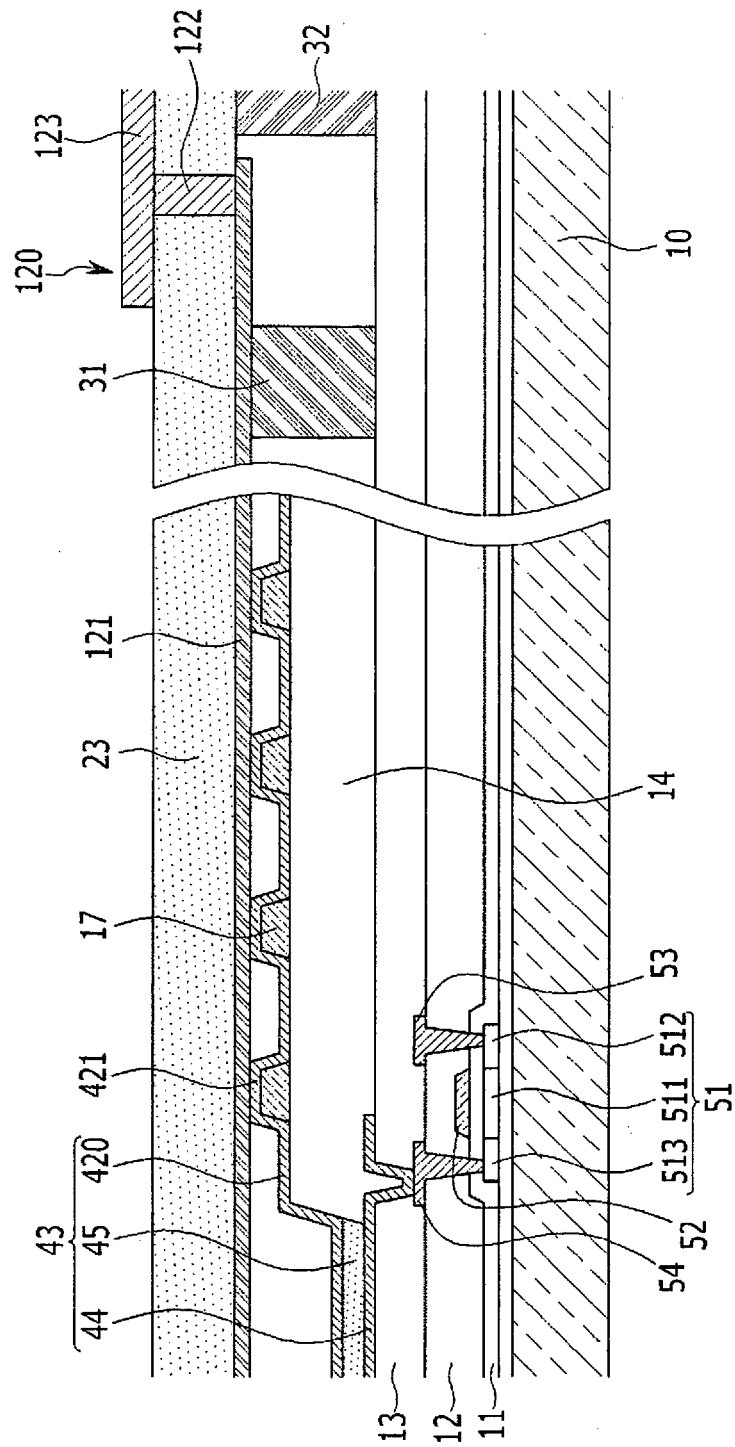


FIG. 18



专利名称(译)	显示装置和有机发光二极管显示器		
公开(公告)号	EP2413394B1	公开(公告)日	2014-08-27
申请号	EP2011175528	申请日	2011-07-27
[标]申请(专利权)人(译)	三星显示有限公司		
申请(专利权)人(译)	三星移动显示器有限公司.		
当前申请(专利权)人(译)	三星DISPLAY CO. , LTD.		
[标]发明人	LEE CHOONG HO NAM KIE HYUN LEE JUNG MIN		
发明人	LEE, CHOONG-HO NAM, KIE HYUN LEE, JUNG-MIN		
IPC分类号	H01L51/52 H01L27/32		
CPC分类号	H01L51/5237 H01L27/3276 H01L51/524 H01L51/5243 H01L51/5246		
优先权	1020100073513 2010-07-29 KR		
其他公开文献	EP2413394A2 EP2413394A3		
外部链接	Espacenet		

摘要(译)

一种显示装置，包括：显示基板（10）；显示单元（40）形成在显示基板上，密封基板（20）通过围绕显示单元的粘附层（31,32,33）固定到显示基板上。密封基板包括复合构件（23）和绝缘构件（24），复合构件（23）包括树脂和多个碳纤维，绝缘构件（24）附接到复合构件。绝缘构件包括通孔（21）。金属膜设置在密封基板的一侧，面对显示基板；导电连接部分（110）通过通孔与金属膜接触。

FIG.1

100 I

